Nokia Customer Care

Service Manual

RM-217; RM-222 (Nokia 6300; Nokia 6300b) **Mobile Terminal**

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COMPANY CONFIDENTIAL

NOKIA

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Amendment Record Sheet

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IMPORTANT

This document is intended for use by qualified service personnel only.

Warnings and cautions

Warnings

- IF THE DEVICE CAN BE INSTALLED IN A VEHICLE, CARE MUST BE TAKEN ON INSTALLATION IN VEHICLES FITTED WITH ELECTRONIC ENGINE MANAGEMENT SYSTEMS AND ANTI-SKID BRAKING SYSTEMS. UNDER CERTAIN FAULT CONDITIONS, EMITTED RF ENERGY CAN AFFECT THEIR OPERATION. IF NECESSARY, CONSULT THE VEHICLE DEALER/ MANUFACTURER TO DETERMINE THE IMMUNITY OF VEHICLE ELECTRONIC SYSTEMS TO RF ENERGY.
- THE PRODUCT MUST NOT BE OPERATED IN AREAS LIKELY TO CONTAIN POTENTIALLY EXPLOSIVE ATMOSPHERES, FOR EXAMPLE, PETROL STATIONS (SERVICE STATIONS), BLASTING AREAS ETC.
- OPERATION OF ANY RADIO TRANSMITTING EQUIPMENT, INCLUDING CELLULAR TELEPHONES, MAY INTERFERE WITH THE FUNCTIONALITY OF INADEQUATELY PROTECTED MEDICAL DEVICES. CONSULT A PHYSICIAN OR THE MANUFACTURER OF THE MEDICAL DEVICE IF YOU HAVE ANY QUESTIONS. OTHER ELECTRONIC EQUIPMENT MAY ALSO BE SUBJECT TO INTERFERENCE.
- BEFORE MAKING ANY TEST CONNECTIONS, MAKE SURE YOU HAVE SWITCHED OFF ALL EQUIPMENT.

Cautions

- Servicing and alignment must be undertaken by qualified personnel only.
- Ensure all work is carried out at an anti-static workstation and that an anti-static wrist strap is worn.
- Ensure solder, wire, or foreign matter does not enter the telephone as damage may result.
- Use only approved components as specified in the parts list.
- Ensure all components, modules, screws and insulators are correctly re-fitted after servicing and alignment.
- Ensure all cables and wires are repositioned correctly.
- During testing never activate the GSM transmitter without a proper antenna load, otherwise the GSM PA may be damaged.



For your safety

QUALIFIED SERVICE

Only qualified personnel may install or repair phone equipment.

ACCESSORIES AND BATTERIES

Use only approved accessories and batteries. Do not connect incompatible products.

CONNECTING TO OTHER DEVICES

When connecting to any other device, read its user's guide for detailed safety instructions. Do not connect incompatible products.

Care and maintenance

This product is of superior design and craftsmanship and should be treated with care. The suggestions below will help you to fulfil any warranty obligations and to enjoy this product for many years.

- Keep the phone and all its parts and accessories out of the reach of small children.
- Keep the phone dry. Precipitation, humidity and all types of liquids or moisture can contain minerals that will corrode electronic circuits.
- Do not use or store the phone in dusty, dirty areas. Its moving parts can be damaged.
- Do not store the phone in hot areas. High temperatures can shorten the life of electronic devices, damage batteries, and warp or melt certain plastics.
- Do not store the phone in cold areas. When it warms up (to its normal temperature), moisture can form inside, which may damage electronic circuit boards.
- Do not drop, knock or shake the phone. Rough handling can break internal circuit boards.
- Do not use harsh chemicals, cleaning solvents, or strong detergents to clean the phone.
- Do not paint the phone. Paint can clog the moving parts and prevent proper operation.
- Use only the supplied or an approved replacement antenna. Unauthorised antennas, modifications or attachments could damage the phone and may violate regulations governing radio devices.

All of the above suggestions apply equally to the product, battery, charger or any accessory.

ESD protection

Nokia requires that service points have sufficient ESD protection (against static electricity) when servicing the phone.

Any product of which the covers are removed must be handled with ESD protection. The SIM card can be replaced without ESD protection if the product is otherwise ready for use.

To replace the covers ESD protection must be applied.

All electronic parts of the product are susceptible to ESD. Resistors, too, can be damaged by static electricity discharge.

All ESD sensitive parts must be packed in metallized protective bags during shipping and handling outside any ESD Protected Area (EPA).

Every repair action involving opening the product or handling the product components must be done under ESD protection.

ESD protected spare part packages MUST NOT be opened/closed out of an ESD Protected Area.

For more information and local requirements about ESD protection and ESD Protected Area, contact your local Nokia After Market Services representative.

Battery information

Note: A new battery's full performance is achieved only after two or three complete charge and discharge cycles!

The battery can be charged and discharged hundreds of times but it will eventually wear out. When the operating time (talk-time and standby time) is noticeably shorter than normal, it is time to buy a new battery.

Use only batteries approved by the phone manufacturer and recharge the battery only with the chargers approved by the manufacturer. Unplug the charger when not in use. Do not leave the battery connected to a charger for longer than a week, since overcharging may shorten its lifetime. If left unused a fully charged battery will discharge itself over time.

Temperature extremes can affect the ability of your battery to charge.

For good operation times with Ni-Cd/NiMh batteries, discharge the battery from time to time by leaving the product switched on until it turns itself off (or by using the battery discharge facility of any approved accessory available for the product). Do not attempt to discharge the battery by any other means.

Use the battery only for its intended purpose.

Never use any charger or battery which is damaged.

Do not short-circuit the battery. Accidental short-circuiting can occur when a metallic object (coin, clip or pen) causes direct connection of the + and - terminals of the battery (metal strips on the battery) for example when you carry a spare battery in your pocket or purse. Short-circuiting the terminals may damage the battery or the connecting object.

Leaving the battery in hot or cold places, such as in a closed car in summer or winter conditions, will reduce the capacity and lifetime of the battery. Always try to keep the battery between 15°C and 25°C (59°F and 77° F). A phone with a hot or cold battery may temporarily not work, even when the battery is fully charged. Batteries' performance is particularly limited in temperatures well below freezing.

Do not dispose of batteries in a fire!

Dispose of batteries according to local regulations (e.g. recycling). Do not dispose as household waste.

Company Policy

Our policy is of continuous development; details of all technical modifications will be included with service bulletins.

While every endeavour has been made to ensure the accuracy of this document, some errors may exist. If any errors are found by the reader, NOKIA MOBILE PHONES Business Group should be notified in writing/e-mail.

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Nokia 6300; Nokia 6300b Service Manual Structure

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 Parts and layouts
 Service Software Instructions
 Service Tools and Service Concepts
 Disassembly and reassembly instructions
 BB Troubleshooting and Manual Tuning Guide
 RF Troubleshooting and Manual Tuning Guide
 System module
 Schematics
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1 — General information



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Product selection

The RM-217 and RM-222 are class 4 (max 2W) GSM triband hand portable phones, supporting GSM 850/1800/1900 (RM-222) and 900/1800/1900 (RM-217) bands, respectively. The RM-217/222 also supports EGPRS and GPRS (Packed data). It is a class B&C terminal, supporting EGPRS multislot class 10 (4Rx + 1Tx and 3Rx + 2Tx) and GPRS multislot class 10 (4+1, 3+2).

The RM-217/222 is MMS (Multimedia Messaging Services) version 1.2 enabled phone with a QVGA 240x320 pixel, active TFT 16.7 million colour display. It also has an integrated 2 Mpix digital camera with a 8 x digtal zoom.

The RM-217/222 has a 3GPP video player/recorder, FM stereo radio and a music player, and it supports Bluetooth 2.0 + EDR standard as well as microSD card with hotswap possibility.

The XHTML/WAP browser in RM-217/222 is compatible with the version 2.0 specifications and it supports HTTP/TCP/IP stack.

In addition the RM-217/222 is a Java-enabled phone (JavaTM 2 Platform, Micro Edition, for embedded devices). It supports MIDP Java 2.0 with additionally APIs.

The supported user interface is S40, that is, RM-217/222 software is based on the ISA platform.



Figure 1 View of RM-217/222

Features

Phone features

General features

• Demo mode (phone demo without SIM card)

Hardware features

Display and keypad features

- Main display: Active TFT QVGA display supporting up to 16,7 million colors (320 x 240 pixels, 2 inches active area)
- Power switch
- Side volume keys

Hardware characteristics

- Monoblock phone
- 2-Mpix camera with 8 x digital zoom
- Hotswap µSD memory card slot (under the battery cover)
- Stereo FM radio and music player
- Integrated handsfree speaker
- Internal vibra
- Bluetooth
- 2.0 mm DC charger plug interface
- Mini-USB connector
- 2.5mm Nokia AV connector

Software and User interface features

Software features

- ISA OS 8.0s Platform
- Nokia Series 40 User interface (UI): Java[™] MIDP 2.0

UI features

Imaging	 2.0-megapixel camera with 8x digital zoom (1600 x 1200 pixel resolution)
	Full-screen viewfinder
	PictBridge printing via USB cable
Multimedia	• MP3 player supporting formats including MP3, Midi, AAC, AAC+, enhanced AAC+, WMA
	FM stereo radio, Visual Radio and music player
	3GPP video player/recorder
	 MP3 ringing tones, True tones and MIDI tones, with support of 64 polyphony
Memory functions	 Combo memory with 32 MB flash and 16 MB RAM – about 7 MB user memory (for gallery and applications, contacts, notes, calendar entries)
	 Hotswap microSD memory card slot supporting up to 2GB microSD memory cards (available as enhancements)

Messaging	Simplified messaging with recently used contacts log and groups
	 Email: Access your work and private email accounts; supports SMTP, POP3, and IMAP4 protocols. Support for attachments (Java version)
	 Audio messaging service (AMS): Record your own voice message and send to compatible devices
	 MMS OMA 1.2: Combine image, video, text, and voice clips and send as an MMS to a compatible phone or PC; use MMS to tell your story with a multi- slide presentation. The MMS OMA 1.2 specification allows you to send/ receive messages up to 300 kB in size.
	 Text messaging: Supports concatenated SMS, picture messaging, SMS distribution list
	 Predictive text input: Support for all major languages in Europe and Asia- Pacific
	Instant Messaging (IM)
Applications	• Java™ MIDP 2.0 with over-the-air download
	 Pre-installed Java[™]-based applications and games
	SIM Application Toolkit
	Wireless Presenter
Connectivity	Nokia PC Suite with USB and Bluetooth connectivity
	 Bluetooth wireless connectivity (SIM access, headset, and handsfree profiles) incl. stereo support for headsets
	Nokia AV connector interface with USB
	FOTA (Flashing over-the-air)
	Local/remote SyncML data synchronization
Browsing	Integrated XHTML browser
	Smart content download - OMA DRM 2.0
Data transfer	• EDGE (EGPRS): Class 10, download up to 236.8 kbps
	GPRS: Class 10, download up to 53.6 kbps
	Note: Actual achieved speeds may vary depending on network support
	 GPRS/EDGE/HSCSD/CSD for browsing and as data modem
	Downlink Advanced Receiver Performance (DARP)
Voice features	 Push To Talk: Select the person or group you want to talk to and press the Push To Talk key to communicate
	 Enhanced voice dialling with SIND: Speaker-independent name dialling for easy call handling
	 Integrated handsfree speaker with a new high quality speaker for better audio experience (stereo widening effects when attaching the headset)
	Voice commands
	Voice recorder

Digital services	 User Interface (UI) themes including e.g. animated wallpapers, screensavers, color schemes, ringing tones
	 Ringing tones: Video, MP3 ringing tones, True Tones and MIDI ringing, alert, and gaming tones with support of 64 polyphony
	 OTA download possibility for: Themes, True Tones, MP3 ringing tones, MIDI ringing tones, screensavers, wallpapers, 3GPP streaming, images and videos, Series 40 Java games and applications
Personal information management (PIM)	 Organizer with alarm clock, calendar, to-do list, notes, calculator, countdown timer, and stopwatch
	 Manage your time and information with the enhanced calendar that can be synchronized, for example, with Microsoft and Lotus PIM application calendars by using the Nokia PC Suite
Call management	Speed dialling
	 Logs: Keeps lists of your dialled, received, and missed calls
	 Automatic answer (works with headset or car kit only)
	Call waiting, call hold, call divert, call timer

Accessories

Туре	Name
AD-42W	Wireless audio gateway
HS-40	Mono headset
HS-16, HS-42, HS-47	Stereo headsets
BH-300, BH-601, BH-700, BH-800, BH-900, HS-4W, HS-50W	Wireless mono headsets
HS-21W, HS-24W, HS-25W, HS-26W, HS-34W, HS-36W, HS-37W, HS-57W, HS-57W, HS-58W	Wireless stereo headsets

Table 1 Audio

Table 2 Battery and chargers

Туре	Name
Note: This phone is charged through the smaller Nokia standard interface (2.0 mm plug). The 3.5 mm standard charger can be used together with the CA-44 charger adapter.	
AC-3/AC-5	Compact charger
AC-4	Travel charger
BL-4C	Battery 860 mAh Li-Ion
CA-44	Charger adapter (from 3.5 mm -> 2 mm)

Table 3 Car accessories

Туре	Name
CK-1W	Wireless car kit
CK-7W	Basic universal car kit
CK-20W	Car Installation Kit
CR-39	Universal holder
DC-4	Mobile charger
HF-35W	Wireless Car Handsfree
N616	Car phone

Table 4 Data

Туре	Name
DKE-2	Mini USB connectivity cable
MU-22	1 GB μSD card
MU-26	128 MB μSD card
MU-27	256 MB μSD card
MU-28	512 MB μSD card
MU-37	2 GB μSD card

Table 5 Imaging

Туре	Name
РТ-6	Remote camera



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2 — Parts and layouts



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Exploded view

Exploded view



Mechanical spare parts overview



6300 RM-217 / 6300b RM-222 SPARE PARTS OVERVIEW

Parts list

Mechanical spare parts list

Note: For Nokia product codes, please refer to the latest Service Bulletins on the Partner Website (PWS).

To ensure you are always using the latest codes, please check the PWS on a daily basis.

Ax and in bold = ASSY

"-" = NOT AVAILABLE

"XXXXXXX" = VARIANTS

"??????" = Code available in Bulletin

I0xx = ITEM codes for upper or mono block

I1xx = ITEM codes for hinge block

I2xx = ITEM codes for lower block

I3xx = ITEM codes for soldered spare parts on the upper, hinge or lower block and not exchangeable

ITEM/ CIRCUIT REF.	QTY	PART NAME	Note
I0001	1	A-COVER ASSY	
10002	1	КЕҮМАТ	
10003	4	SCREW 1.6X4.5 TORX PLUS	
10004	1	UI SHIELD ASSEMBLY	
10005	1	LCD MODULE	
A1	1	1YW LIGHT SWAP PACKAGE (10006 - 10014)	
10006	1	DOMESHEET	Cannot be reused when removed.
10007	1	1YW LIGHT SWAP PWB	
10008	1	FM SHIELDING LID	Cannot be reused when removed.
10009	1	RETU-TAHVO SHIELDING LID	Cannot be reused when removed.
I0010	1	RAP MEM SHIELDING LID	Cannot be reused when removed.
I0011	1	HWA SHIELDING LID	Cannot be reused when removed.
I0012	1	RF SHIELDING LID	Cannot be reused when removed.
I0013	1	BT SHIELDING LID	Cannot be reused when removed.
I0014	1	TYPE LABEL	Cannot be reused when removed.
I0015	1	CAMERA GASKET	
I0016	1	CAMERA	
10017	1	FLEX SHIELDING LID ASSY	Cannot be reused when removed.
A2	1	ANTENNA MODULE ASSY (I0018 - I0021)	
I0018	1	EARPIECE ASSEMBLY	

ITEM/ CIRCUIT REF.	QTY	PART NAME	Note
I0019	1	PLASTIC CHAMBER	
10020	1	IHF SPEAKER	
I0021	1	ANTENNA RADIATOR	
A3	1	B-COVER ASSY (10022 - 10030)	
I0022	1	B-COVER	
I0023	1	POWER KEY	
I0024	1	VOLUME KEY	
I0025	1	SIDE WINDOW RIGHT	
I0026	1	LED WINDOW LEFT	
I0027	1	MICROPHONE	
I0028	1	DC JACK	
10029	1	USB DOOR	
10030	1	LABEL COVER ASSY	
I0031	2	SCREW 1.6 x 4.5 REMFORM TORX PLUS	
I0032	1	C-COVER	
19998	1	WATER INGRESS LABEL	

Note

Antenna Module is marked 850 or 900 to enable identification of different versions by regions.

Component parts list (1ywa_32a)

Item	Side	Grid		Side Grid		Description and value	
A2200	Bottom	к	3	SHIELD_040_025976	RETU TAHVO SHIELD ASSY 040-025976 P2912		
A2400	Bottom	т	3	SHIELD_0264510	FLEX SHIELD FRAME 031886 P2908		
A2800	Bottom	к	7	SHIELD_040_025979	RAP_MEM SHIELD ASSY 040-025979 P2912		
A3300	Bottom	0	8	SHIELD_040_025020	HW_ACC ASSEMBLY 040-025020 P2912		
A6000	Bottom	Q	2	SHIELD_040_031454	BT SHIELD ASSY 031454 P2908		
A6100	Bottom	G	6	SHIELD_040_031457	FM SHIELD ASSY 031457 P2908		
A7000	Bottom	R	6	SHIELD_040_009342	RF ASSEMBLY 040-009342 P2465		

Item	Side	Grid		Description and value		
B2100	Bottom	В	8	MIC_OBE_415S42_RC3310C L_CARBON	CLAPTON EMC MICROPHONE MOD -42DB	
B2101	Bottom	т	6	SPEAKER_LTR_RDF_COMB	EARP RDF-07A 320HM 10.86x7.40.2.25	
B2200	Bottom	м	3	CRYSTAL_3.3X1.6_H0.9	CRYSTAL 32.768KHZ +/-30PPM 12.5PF	
C2000	Тор	Α	4	0402C	CHIPCAP NP0 27P J 50V 0402	
C2001	Тор	A	3	0603C_H0.95	CHIPCAP X5R 470N K 25V 0603	
C2002	Тор	Α	5	0603C	CHIPCAP X7R 10N K 50V 0603	
C2008	Bottom	C	2	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2030	Bottom	E	5	0402C	CHIPCAP NP0 270P J 50V 0402	
C2031	Bottom	E	5	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2032	Bottom	D	5	0402C	CHIPCAP X7R 10N K 16V 0402	
C2033	Bottom	E	4	0402C	CHIPCAP X7R 33N K 10V 0402	
C2034	Bottom	E	4	0402C	CHIPCAP X7R 33N K 10V 0402	
C2035	Bottom	C	5	0402C	CHIPCAP NP0 27P J 50V 0402	
C2040	Bottom	Н	5	0603C	CHIPCAP X5R 2U2 K 6V3 0603	
C2041	Bottom	C	3	0603C	CHIPCAP X5R 2U2 K 6V3 0603	
C2042	Bottom	D	4	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2043	Bottom	C	4	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2044	Bottom	C	4	0402C	CHIPCAP NPO 18P J 50V 0402	
C2045	Bottom	D	5	0402C	CHIPCAP NPO 18P J 50V 0402	
C2046	Bottom	C	4	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C2047	Bottom	C	4	0603C	CHIPCAP X5R 4U7 K 6.3V 0603	
C2048	Bottom	C	3	0603C	CHIPCAP X5R 2U2 K 6V3 0603	
C2049	Bottom	Н	5	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2050	Bottom	D	5	0402C	CHIPCAP X7R 10N K 16V 0402	
C2051	Bottom	Н	5	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2052	Bottom	C	5	0402C	CHIPCAP NP0 27P J 50V 0402	
C2071	Bottom	Q	3	0402C	CHIPCAP NP0 27P J 50V 0402	
C2073	Bottom	S	2	TANT_C_6.2X3.4_H1.7	CHIPTCAP 150U M 10V 6X3.2X1.5	
C2074	Bottom	L	2	0402C	CHIPCAP X7R 10N K 16V 0402	
C2076	Bottom	Q	4	0402C	CHIPCAP X7R 10N K 16V 0402	
C2077	Bottom	М	2	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2078	Bottom	М	2	0402C	CHIPCAP NP0 27P J 50V 0402	
C2079	Bottom	E	4	0402C	CHIPCAP X7R 1N0 K 50V 0402	



Item	Side	Gi	rid	Descript	tion and value
C2080	Bottom	E	4	0402C	CHIPCAP X7R 10N K 16V 0402
C2100	Bottom	G	5	0402C	CHIPCAP X7R 33N K 10V 0402
C2101	Bottom	F	5	0402C	CHIPCAP X7R 33N K 10V 0402
C2102	Bottom	Н	5	0603C	CHIPCAP X5R 2U2 K 6V3 0603
C2103	Bottom	0	1	0402C	CHIPCAP NP0 27P J 50V 0402
C2104	Bottom	0	2	0402C	CHIPCAP NP0 27P J 50V 0402
C2200	Bottom	М	5	0603C	CHIPCAP X5R 1U K 6V3 0603
C2201	Bottom	М	2	0603C	CHIPCAP X5R 1U K 6V3 0603
C2202	Bottom	N	2	0402C	CHIPCAP X7R 1N0 K 50V 0402
C2203	Bottom	М	4	0402C	CHIPCAP X7R 1N0 K 50V 0402
C2204	Bottom	М	4	0402C	CHIPCAP X7R 1N0 K 50V 0402
C2205	Bottom	М	4	0402C	CHIPCAP X7R 1N0 K 50V 0402
C2206	Bottom	М	4	0402C	CHIPCAP X7R 1N0 K 50V 0402
C2207	Bottom	N	2	0402C	CHIPCAP X7R 1N0 K 50V 0402
C2208	Bottom	N	3	0402C	CHIPCAP NP0 27P J 50V 0402
C2209	Bottom	N	3	0402C	CHIPCAP NP0 22P J 50V 0402
C2210	Bottom	К	3	0603C	CHIPCAP X5R 1U K 16V 0603
(2211	Bottom	К	3	0805C	CHIPCAP X5R 4U7 K 10V 0805
(2212	Bottom	К	3	0402C	CHIPCAP X5R 1U5 K 4V 0402
(2213	Bottom	L	3	0402C	CHIPCAP X5R 1U5 K 4V 0402
(2214	Bottom	L	2	0402C	CHIPCAP X5R 1U5 K 4V 0402
(2215	Bottom	L	2	0402C	CHIPCAP X5R 1U5 K 4V 0402
C2216	Bottom	L	2	0402C	CHIPCAP X5R 1U5 K 4V 0402
(2217	Bottom	М	3	0402C	CHIPCAP X5R 1U5 K 4V 0402
(2219	Bottom	М	2	0402C	CHIPCAP X5R 1U5 K 4V 0402
C2220	Bottom	К	3	0402C	CHIPCAP X5R 1U5 K 4V 0402
(2221	Bottom	К	2	0603C	CHIPCAP X5R 1U K 6V3 0603
(2222	Bottom	К	2	0603C	CHIPCAP X5R 1U K 6V3 0603
(2223	Bottom	L	4	0402C	CHIPCAP X7R 10N K 16V 0402
C2224	Bottom	М	4	0402C	CHIPCAP X7R 10N K 16V 0402
(2225	Bottom	М	2	0603C	CHIPCAP X5R 1U K 6V3 0603
C2226	Bottom	L	2	0603C	CHIPCAP X5R 1U K 6V3 0603
C2227	Bottom	К	3	0603C	CHIPCAP X5R 1U K 6V3 0603
C2228	Bottom	L	2	0603C	CHIPCAP X5R 1U K 6V3 0603
C2230	Bottom	м	3	0603C	CHIPCAP X5R 1U K 6V3 0603

Item	Side	Grid		Description and value		
C2231	Bottom	К	5	0805C	CHIPCAP X5R 10U M 6V3 0805	
C2232	Bottom	L	2	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2270	Bottom	L	5	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2271	Bottom	L	5	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2272	Bottom	L	5	0402C	CHIPCAP X7R 1N0 K 50V 0402	
(2273	Bottom	К	4	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2274	Bottom	K	4	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2275	Bottom	К	4	0402C	CHIPCAP X7R 1N0 K 50V 0402	
C2281	Bottom	L	2	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2300	Bottom	J	4	0402C	CHIPCAP X7R 10N K 16V 0402	
C2301	Bottom	Ι	4	0805C	CHIPCAP X5R 22U M 6V3 0805	
C2302	Bottom	К	5	0805C	CHIPCAP X5R 22U M 6V3 0805	
C2303	Bottom	Ι	3	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2304	Bottom	К	4	0402C	CHIPCAP X7R 10N K 16V 0402	
C2305	Bottom	Ι	2	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2306	Bottom	I	4	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2307	Bottom	I	4	0603C	CHIPCAP X5R 1U K 6V3 0603	
C2309	Bottom	I	5	0805C	CHIPCAP X5R 22U M 6V3 0805	
(2312	Bottom	I	3	0603C	CHIPCAP X5R 1U K 6V3 0603	
(2313	Bottom	I	3	0603C	CHIPCAP X5R 1U K 6V3 0603	
(2314	Bottom	J	2	0805C	CHIPCAP X5R 4U7 K 10V 0805	
(2315	Bottom	К	2	0805C	CHIPCAP X5R 4U7 M 25V 0805	
(2317	Bottom	J	2	0402C	CHIPCAP NP0 27P J 50V 0402	
C2403	Bottom	N	2	0402C	CHIPCAP NP0 47P J 50V 0402	
C2404	Bottom	Т	2	0402C	CHIPCAP X7R 4N7 K 25V 0402	
C2405	Bottom	Т	4	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C2413	Bottom	I	2	0402C	CHIPCAP NP0 27P J 50V 0402	
C2414	Bottom	Т	2	0402C	CHIPCAP NP0 27P J 50V 0402	
C2415	Bottom	Т	4	0402C	CHIPCAP NP0 27P J 50V 0402	
C2416	Bottom	Т	3	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C2417	Bottom	Т	3	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C2418	Bottom	Т	3	0402C	CHIPCAP NP0 27P J 50V 0402	
C2700	Bottom	Н	2	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C2701	Bottom	Н	2	0402C	CHIPCAP NP0 27P J 50V 0402	
C2800	Bottom	L	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	



Item	Side	Gi	rid	Descript	ion and value
C2801	Bottom	N	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2802	Bottom	М	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2803	Bottom	L	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2804	Bottom	N	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2805	Bottom	К	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2807	Bottom	N	8	0603C	CHIPCAP X5R 1U K 6V3 0603
C2808	Bottom	М	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2809	Bottom	М	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2810	Bottom	К	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2811	Bottom	К	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2812	Bottom	L	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2813	Bottom	N	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2814	Bottom	М	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2815	Bottom	К	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2816	Bottom	К	8	0402C	CHIPCAP NP0 27P J 50V 0402
C2818	Bottom	К	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2819	Bottom	К	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2820	Bottom	N	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C2821	Bottom	N	6	0402C	CHIPCAP NP0 27P J 50V 0402
C2831	Bottom	N	7	0402C	CHIPCAP NPO 1PO C 50V 0402
C3000	Bottom	I	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3001	Bottom	J	6	0402C	CHIPCAP X7R 10N K 16V 0402
C3002	Bottom	J	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3003	Bottom	К	8	0402C	CHIPCAP X7R 10N K 16V 0402
C3004	Bottom	К	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3005	Bottom	J	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3006	Bottom	I	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3007	Bottom	J	8	0402C	CHIPCAP X7R 10N K 16V 0402
C3008	Bottom	J	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3009	Bottom	I	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3010	Bottom	N	5	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3013	Bottom	К	7	0402C	CHIPCAP NP0 27P J 50V 0402
C3014	Bottom	К	7	0402C	CHIPCAP NP0 68P J 50V 0402
C3100	Bottom	E	2	0402C	CHIPCAP NP0 27P J 50V 0402
(3115	Bottom	0	7	0402C	CHIPCAP X5R 1U K 6V3 0402

Item	Side	Gr	id	Descript	ion and value
(3116	Bottom	0	7	0402C	CHIPCAP X7R 10N K 16V 0402
C3200	Bottom	G	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3201	Bottom	Н	8	0402C	CHIPCAP X5R 1U K 6V3 0402
C3202	Bottom	Н	7	0402C	CHIPCAP X7R 10N K 16V 0402
C3203	Bottom	G	8	0402C	CHIPCAP X5R 1U K 6V3 0402
C3204	Bottom	Н	7	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3210	Bottom	G	8	0402C	CHIPCAP NP0 27P J 50V 0402
(3211	Тор	D	8	0402C	CHIPCAP NP0 27P J 50V 0402
C3300	Bottom	Р	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3301	Bottom	N	5	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3302	Bottom	N	4	0402C	CHIPCAP X5R 220N K 6.3V 0402
C3303	Bottom	0	8	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402
C3304	Bottom	0	8	0402C	CHIPCAP X7R 10N K 16V 0402
C3305	Bottom	0	6	0603C	CHIPCAP X5R 4U7 K 6.3V 0603
C3306	Bottom	0	8	0603C	CHIPCAP X5R 4U7 K 6.3V 0603
C3307	Bottom	0	8	0603C	CHIPCAP X5R 10UF 6V3 0603
C3308	Bottom	N	5	0402C	CHIPCAP X5R 1U K 6V3 0402
C3309	Bottom	N	5	0402C	CHIPCAP NP0 27P J 50V 0402
C3310	Bottom	Р	6	0402C	CHIPCAP NP0 27P J 50V 0402
(3313	Bottom	0	8	0402C	CHIPCAP X7R 10N K 16V 0402
(3314	Bottom	Р	8	0402C	CHIPCAP X7R 10N K 16V 0402
C6020	Bottom	Т	2	0402C	CHIPCAP NPO 1P5 C 50V 0402
C6031	Bottom	R	1	0402C	CHIPCAP NP0 18P J 50V 0402
C6032	Bottom	Р	2	0402C	CHIPCAP NPO 100P J 50V 0402
C6033	Bottom	Р	2	0402C	CHIPCAP X7R 10N K 16V 0402
C6034	Bottom	Р	2	0402C	CHIPCAP X7R 10N K 16V 0402
C6035	Bottom	Р	1	0402C	CHIPCAP X7R 10N K 16V 0402
C6036	Bottom	Р	2	0402C	CHIPCAP X7R 10N K 16V 0402
C6037	Bottom	Р	2	0402C	CHIPCAP X5R 1U5 K 4V 0402
C6038	Bottom	Q	1	0402C	CHIPCAP X7R 10N K 16V 0402
C6039	Bottom	Q	2	0402C	CHIPCAP NPO 18P J 50V 0402
C6040	Bottom	Р	2	0402C	CHIPCAP X5R 1U K 6V3 0402
C6051	Bottom	Q	2	0402C	CHIPCAP NP0 2P7 C 50V 0402
C6052	Bottom	Q	2	0402C	CHIPCAP NP0 2P7 C 50V 0402
C6055	Bottom	Q	2	0603C	CHIPCAP X5R 1U K 6V3 0603



Item	Side	Grid		Description and value		
C6100	Bottom	G	7	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C6101	Bottom	Н	6	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C6102	Bottom	G	7	0402C	CHIPCAP X7R 10N K 16V 0402	
C6103	Bottom	G	7	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C6104	Bottom	Н	6	0402C	CHIPCAP NP0 47P J 50V 0402	
C6105	Bottom	G	6	0402C	CHIPCAP NP0 100P J 50V 0402	
C6106	Bottom	Н	6	0402C	CHIPCAP NP0 27P J 50V 0402	
C6107	Bottom	н	6	0405_2_P0.65_AVX	CHIP ARRAY X5R 2X100N M 10V 0405	
C6108	Bottom	н	6	0405_2_P0.65_AVX	CHIP ARRAY X5R 2X100N M 10V 0405	
C6109	Bottom	G	6	0402C	CHIPCAP X5R 1U5 K 4V 0402	
C7000	Bottom	U	8	0402C	CHIPCAP NP0 1P5 C 50V 0402	
C7001	Bottom	Т	8	0402C	CHIPCAP NP0 1P5 C 50V 0402	
C7010	Bottom	N	5	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C7011	Bottom	N	4	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C7012	Bottom	N	5	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C7013	Bottom	N	4	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C7501	Bottom	S	5	0402C	CHIPCAP NP0 2P7 C 50V 0402	
C7502	Bottom	Q	5	0402C	CHIPCAP NPO OP5 C 50V 0402	
C7503	Bottom	Q	4	0603C	CHIPCAP X5R 1U K 6V3 0603	
C7504	Bottom	S	5	0603C	CHIPCAP X5R 1U K 6V3 0603	
C7505	Bottom	Q	4	0402C	CHIPCAP X5R 1U K 6V3 0402	
C7506	Bottom	Q	4	0402C	CHIPCAP X5R 1U K 6V3 0402	
C7507	Bottom	Q	4	0402C	CHIPCAP X7R 10N K 16V 0402	
C7508	Bottom	Q	5	0402C	CHIPCAP NP0 18P J 50V 0402	
C7509	Bottom	R	4	0402C	CHIPCAP X7R 10N K 16V 0402	
C7511	Bottom	R	4	0603C	CHIPCAP NPO 2N2 G 16V 0603	
C7513	Bottom	Q	4	0402C	CHIPCAP X7R 10N K 16V 0402	
C7515	Bottom	S	4	0402C	CHIPCAP NP0 4P7 C 50V 0402	
C7516	Bottom	S	4	0402C	CHIPCAP NP0 470P J 50V 0402	
C7518	Bottom	Q	5	0402C_H0.6	CHIPCAP X5R 100N K 16V 0402	
C7520	Bottom	S	8	0402C	CHIPCAP NP0 3P3 C 50V 0402	
C7521	Bottom	S	8	0402C	CHIPCAP NP0 1P5 C 50V 0402	
(7522	Bottom	Q	8	0402C	CHIPCAP NP0 1P8 C 50V 0402	
Item	Side	Grid		Description and value		
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(7523	Bottom	S	8	0402C	CHIPCAP X5R 1U K 6V3 0402	
(7524	Bottom	Q	7	0402C	CHIPCAP X5R 1U K 6V3 0402	
(7525	Bottom	Q	9	0402C	CHIPCAP NP0 18P J 50V 0402	
C7560	Bottom	R	3	0402C	CHIPCAP NPO 1P2 C 50V 0402	
C7561	Bottom	R	4	0402C	CHIPCAP X7R 820P J 50V 0402	
C7562	Bottom	Q	6	0402C	CHIPCAP NP0 39P J 50V 0402	
C7563	Bottom	Q	5	0402C	CHIPCAP NP0 47P J 50V 0402	
C7564	Bottom	S	4	0402C	CHIPCAP X7R 10N K 16V 0402	
C7565	Bottom	Q	5	0402C	CHIPCAP NP0 47P J 50V 0402	
C7566	Bottom	R	4	0402C	CHIPCAP NP0 4P7 C 50V 0402	
D2200	Bottom	L	3	TFBGA_108	RETU 3.02 LF TSA1GJWE TFBGA108	
D2800	Bottom	L	7	UBGA_289	RAPGSM PA v1.1 LF CO27 uBGA289	
D3000	Bottom	J	7	FBGA133_11.1X10.1	COMBO 256M NOR + 128M DDR DRAM FBGA133	
D3300	Bottom	0	7	TFBGA84	HW ACCELERATOR STV0984N	
E2001	Bottom	D	4	PICK_PLACE_9900821	No description in PDM	
E2002	Bottom	А	6	PICK_PLACE_9900821	No description in PDM	
E2003	Bottom	D	4	PICK_PLACE_9900821	No description in PDM	
E2010	Bottom	Α	7	PICK_PLACE_9900821	No description in PDM	
E2070	Bottom	Р	3	PICK_PLACE_9900821	No description in PDM	
E2071	Bottom	Р	3	PICK_PLACE_9900821	No description in PDM	
E2075	Bottom	Р	4	PICK_PLACE_9900821	No description in PDM	
E2101	Bottom	Q	6	CLIP_040_034164	No description in PDM	
E2102	Bottom	Q	9	CLIP_040_034164	No description in PDM	
E2103	Bottom	U	6	BT_PAD_9900503	No description in PDM	
E2104	Bottom	Т	6	BT_PAD_9900503	No description in PDM	
E2105	Bottom	U	7	BT_PAD_9900503	No description in PDM	
E2106	Bottom	Т	6	BT_PAD_9900503	No description in PDM	
E2401	Тор	C	9	PICK_PLACE_9900821	No description in PDM	
E2402	Тор	C	1	PICK_PLACE_9900821	No description in PDM	
E2403	Тор	Ν	1	PICK_PLACE_9900821	No description in PDM	
E2405	Тор	Т	9	PICK_PLACE_9900821	No description in PDM	
E2407	Тор	Ν	9	PICK_PLACE_9900821	No description in PDM	
E2506	Тор	Т	1	PICK_PLACE_9900821	No description in PDM	

Item	Side	Grid		Description and value	
E6001	Bottom	Т	1	CLIP_040_034164	No description in PDM
E6003	Bottom	Т	1	CLIP_040_034164	No description in PDM
E7000	Bottom	U	8	PICK_PLACE_9900821	No description in PDM
E7001	Bottom	U	5	PICK_PLACE_9900821	No description in PDM
E7501	Bottom	Т	9	CLIP_040_034164	No description in PDM
E7502	Bottom	Т	9	CLIP_040_034164	No description in PDM
E7503	Bottom	U	8	CLIP_040_034164	No description in PDM
F2000	Тор	A	5	0402_FUSE_AVX_H0.5	SM FUSE FF 2A 32V 0402
G2200	Bottom	с	2	BATTER_EECEP	RTC BACKUP CAPAC 311 SIZE FOR 2.6V 4UAH
G7500	Bottom	S	4	VCO_DCS02733	VCO 3296-3980MHZ 4-BAND
G7501	Bottom	Q	3	NKG3176B_H1.0	VCTCXO 38.4MHZ 2.5V 2MA
L2000	Тор	A	5	0603_BLM	FERR.BEAD 220R/100M 2A 0R05 0603
L2030	Bottom	с	5	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2031	Bottom	с	4	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2032	Bottom	D	5	COIL_LK_1608	CHIP COIL 68NH J Q12/100MHZ 0603
L2033	Bottom	D	5	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2034	Bottom	D	5	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2035	Bottom	с	5	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2102	Bottom	Q	7	COIL_LQW1608	CHIP COIL 56N J Q38/200MHZ 0603
L2103	Bottom	Q	8	COIL_LQW1608	CHIP COIL 56N J Q38/200MHZ 0603
L2104	Тор	A	7	0405_2_H1.0	CHIP BEAD ARRAY 2X1000R 0R75 0405
L2105	Bottom	0	2	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L2106	Bottom	0	2	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L2202	Bottom	м	2	0603_BLM	FERR.BEAD 220R/100M 2A 0R05 0603
L2207	Bottom	N	4	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402

Item	Side	Grid		Description and value	
L2208	Bottom	N	4	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L2209	Bottom	M	5	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L2210	Bottom	M	5	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L2211	Bottom	M	4	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L2212	Bottom	M	4	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L2270	Bottom	L	4	0603_BLM	FERR.BEAD 220R/100M 2A 0R05 0603
L2271	Bottom	L	4	0603_BLM	FERR.BEAD 220R/100M 2A 0R05 0603
L2272	Bottom	К	4	0603_BLM	FERR.BEAD 220R/100M 2A 0R05 0603
L2273	Bottom	К	4	0603_BLM	FERR.BEAD 220R/100M 2A 0R05 0603
L2301	Bottom	I	4	0603_BLM	FERR.BEAD 220R/100M 2A 0R05 0603
L2302	Bottom	J	4	CHOKE_SER400_H1.2	INDUCT WW 10U 0A65 0R35 4X4X1.2
L2304	Bottom	J	2	CHOKE_SER300_H1.5	CHOKE 22U M 0R7 0.35A 3.0X3.0X1.5
L2305	Bottom	I	3	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2306	Bottom	I	3	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2402	Bottom	т	3	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2403	Bottom	J	2	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L2404	Bottom	т	3	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L2405	Bottom	0	2	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L3200	Bottom	G	8	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L3301	Bottom	N	6	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402



Item	Side	G	rid	Descript	tion and value
L3303	Bottom	Р	8	CHOKE_SER300	INDUCT WW 2.2UH 1A2 0R168 310 case size
L3304	Bottom	0	9	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L6030	Bottom	Q	2	0402L	CHIP COIL 2N7 +-0N3 Q29/800M 0402
L6031	Bottom	Q	2	0402L	CHIP COIL 2N7 +-0N3 Q29/800M 0402
L6032	Bottom	Q	1	0402L	CHIP COIL 22N J Q28/800MHZ 0402
L6077	Bottom	R	2	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L6100	Bottom	G	7	0402LQW	CHIP COIL 47N +-3% Q25/200MHz 0402
L6101	Bottom	н	6	0402L_P0L2	CHIP COIL 120NH J Q8/100MHZ 0402
L7010	Bottom	N	5	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L7011	Bottom	N	4	0402L	FERR.BEAD 240R/100M 0.4A 0R4 0402
L7500	Bottom	S	6	0402L	CHIP COIL 12N J Q31/800MHZ 0402
L7501	Bottom	s	6	0402L	CHIP COIL 12N J Q31/800MHZ 0402
L7502	Bottom	Q	5	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
L7503	Bottom	Q	8	0402L	CHIP COIL 27N J Q27/800MHZ 0402
L7504	Bottom	R	6	0402L	CHIP COIL 22N J Q28/800MHZ 0402
L7505	Bottom	R	6	0402L	CHIP COIL 22N J Q28/800MHZ 0402
L7515	Bottom	S	4	0402L	CHIP COIL 15N J Q30/800MHZ 0402
L7561	Bottom	Q	6	COIL_HK_1608	CHIP COIL 470NH J 0603
M2100	Bottom	с	8	VIBRA_M_KHN4NX1RA	SMD VIBRA MOTOR 1.3V 90MA 9000RPM
N2030	Bottom	D	5	CSP_8_2.118X1.118	IC ANALOG SWITCH SPDT LOW THRESHOLD CSP8
N2031	Bottom	с	3	XBGA N14	ST HEADPHONE AMPLIFIER LM4920 uSMD14

Item	Side	Grid		Description and value	
N2300	Bottom	J	3	TFBGA_84_6.15X6.15	TAHVO v5.2 LF TFBGA84
N2301	Bottom	J	2	USMD8_1.69X1.69	WHITE LED DRIVER 4LEDS 500mW 8bump USMD8
N2401	Bottom	G	5	SOT_666	TRX2+RX4 PEMD9 N&P 10K/47K 0W12 SOT666
N3200	Bottom	G	8	USMD16_2.03X2.03	VREG & LEVELSHIFT(LP3928) USMD16
N3300	Bottom	0	8	USMD5_1.417X1.087	DC/DC CONV LM3671TLX-1.82V uSMD5
N3301	Bottom	0	6	USMD5_1.47X1.04_H0.675	VREG LP3985ITLX-2.8 NOPB USMD5
N6030	Bottom	Р	2	CSP_47_3.85X4.05	BC4-ROM1.0RDL
N6100	Bottom	Н	7	WLCSP25_3.1X2.9	FM RECEIVER TEA5760 N1C
N7505	Bottom	R	5	TFBGA144	AHNE401A TRANSCEIVER TFBGA144
N7520	Bottom	R	8	RF9282E3.6	PA RF9282E6.5 GSM/EDGE 850/900/1800/1900
R2007	Bottom	C	2	UBGA11_1.6X2.15	ASIP SILIC USB OTG / ESD BGA11
R2008	Bottom	C	2	0402R	CHIPRES 0W06 220K J 0402
R2033	Bottom	E	5	0402R	CHIPRES OW06 10K J 0402
R2034	Bottom	E	5	0402R	CHIPRES OW06 100R J 0402
R2035	Bottom	D	5	0402R	CHIPRES 0W06 100K J 0402
R2036	Bottom	D	5	0402R	CHIPRES OW06 10K J 0402
R2044	Bottom	Н	5	0402R	CHIPRES OW06 220R J 0402
R2045	Bottom	E	5	0402R	CHIPRES OW06 2K2 J 0402
R2049	Bottom	D	4	0402R	CHIPRES OW06 15R J 0402
R2050	Bottom	C	4	0402R	CHIPRES OW06 15R J 0402
R2051	Bottom	с	5	FC5_1.1X1.1	ASIP TVS 4-CH BI ESD 14V 15pF 400um BGA5
R2052	Bottom	C	4	0402R	CHIPRES 0W06 100K J 0402
R2070	Bottom	E	2	0402_NTH5	NTC RES 0W1 47K J B 4050+-3% 0402
R2071	Bottom	N	2	0402_VAR	CHIP VARISTOR VWM14V VC50V 0402
R2072	Bottom	E	4	0402R	CHIPRES OW06 2K2 J 0402
R2074	Bottom	E	5	0402R	CHIPRES OW06 100R J 0402
R2100	Bottom	н	5	FLIP_CHIP_8_1.7X1.7	ASIP SINGLE ENDED MICROPHONE INTERF BGA8



Item	Side	Gr	id	Descript	ion and value
R2101	Bottom	Н	5	0402R	CHIPRES 0W06 220R J 0402
R2102	Bottom	Т	5	0402R	CHIPRES OW06 10R J 0402
R2103	Bottom	Т	5	0402R	CHIPRES OW06 10R J 0402
R2104	Тор	А	8	0402R	CHIPRES JUMPER ORO 0402
R2105	Тор	Α	8	0402R	CHIPRES JUMPER ORO 0402
R2106	Bottom	N	5	0402_VAR	CHIP VARISTOR VWM14V VC50V 0402
R2107	Bottom	N	5	0402_VAR	CHIP VARISTOR VWM14V VC50V 0402
R2200	Bottom	М	2	0402R	CHIPRES 0W06 100K J 0402
R2201	Bottom	Ν	2	0402R	CHIPRES 0W06 120K J 0402
R2202	Bottom	М	5	0402R	CHIPRES JUMPER ORO 0402
R2203	Bottom	М	5	0402R	CHIPRES JUMPER ORO 0402
R2204	Bottom	М	5	0402R	CHIPRES JUMPER ORO 0402
R2205	Bottom	М	5	0402R	CHIPRES JUMPER ORO 0402
R2212	Bottom	L	4	0402R	CHIPRES 0W06 470R J 0402
R2213	Bottom	Ν	3	0402R	CHIPRES 0W06 4K7 J 0402
R2216	Bottom	Ν	3	0402R	CHIPRES 0W06 2M2 J 0402
R2250	Bottom	Ν	2	0402R	CHIPRES 0W06 100K J 0402
R2251	Bottom	Ν	2	0402R	CHIPRES 0W06 100K J 0402
R2303	Bottom	Н	3	0603R	CHIPRES JUMPER ORO 0603
R2400	Bottom	G	4	0603R	CHIPRES JUMPER ORO 0603
R2406	Bottom	Ν	2	0402R	CHIPRES 0W06 27K J 0402
R2407	Bottom	Н	5	0402R	CHIPRES 0W06 47R J 0402
R2408	Bottom	G	4	0402R	CHIPRES 0W06 22K J 0402
R2418	Bottom	Н	4	0402R	CHIPRES 0W06 470R J 0402
R2419	Bottom	Н	5	0402R	CHIPRES 0W06 470R J 0402
R2421	Bottom	К	2	0402R	CHIPRES 0W06 33R J 0402
R2422	Bottom	G	5	0402R	CHIPRES JUMPER ORO 0402
R2423	Bottom	G	5	0402R	CHIPRES 0W06 22K J 0402
R2424	Bottom	Ι	4	0402R	CHIPRES 0W06 27R J 0402
R2425	Bottom	G	4	0402R	CHIPRES OW06 1K0 J 0402
R2426	Bottom	Ν	9	0402R	CHIPRES 0W06 47R J 0402
R2427	Bottom	L	1	0402R	CHIPRES 0W06 47R J 0402
R2430	Bottom	G	4	0402R	CHIPRES 0W06 22K J 0402

Item	Side	Grid		Description and value	
R2803	Bottom	L	8	0402R	CHIPRES OW06 100R J 0402
R2804	Bottom	L	8	0402R	CHIPRES OW06 100R J 0402
R3000	Bottom	J	6	0402R	CHIPRES OW06 4K7 J 0402
R3002	Bottom	L	8	0402R	CHIPRES OW06 10R J 0402
R3003	Bottom	К	6	0402R	CHIPRES OW06 4K7 J 0402
R3004	Bottom	К	7	0402R	CHIPRES OW06 4K7 J 0402
R3200	Bottom	G	8	UBGA11_1.62X2.12	ASIP MMC FILTER *** PB-FREE ***
R3201	Bottom	Н	8	0402R	CHIPRES 0W06 100K J 0402
R3202	Bottom	Н	8	0402R	CHIPRES 0W06 100K J 0402
R3203	Bottom	Н	7	0402R	CHIPRES 0W06 100K J 0402
R3204	Bottom	Н	7	0402R	CHIPRES OW06 2K2 J 0402
R3205	Bottom	G	8	0402R	CHIPRES OW06 680R J 0402
R3206	Bottom	G	8	0402R	CHIPRES OW06 1K2 J 0402
R3300	Bottom	Р	7	0402R	CHIPRES OW06 4K7 J 0402
R3301	Bottom	Р	8	0402R	CHIPRES OW06 4K7 J 0402
R3305	Bottom	0	7	0402R	CHIPRES JUMPER ORO 0402
R3306	Bottom	Р	7	0402R	CHIPRES OW06 100R J 0402
R3307	Bottom	Р	7	0402R	CHIPRES OW06 100R J 0402
R3312	Bottom	I	8	0402R	CHIPRES OW06 1K0 J 0402
R3313	Bottom	I	8	0402R	CHIPRES OW06 1K0 J 0402
R3314	Bottom	0	6	0402R	CHIPRES OW06 47R J 0402
R6005	Bottom	N	2	0402R	CHIPRES 0W06 100K J 0402
R6020	Bottom	Т	2	FERRIT_0402	CHIPRES JUMPER ORO 0402
R6030	Bottom	Р	2	0402R	CHIPRES OW06 10K J 0402
R6031	Bottom	Q	1	0402R	CHIPRES OW06 10K J 0402
R6032	Bottom	Р	2	0402R	CHIPRES OW06 2R2 J 0402
R6034	Bottom	Q	2	0402R	CHIPRES OW06 10K J 0402
R6037	Bottom	Q	1	0402R	CHIPRES 0W06 100K J 0402
R6100	Bottom	G	7	0402R	CHIPRES 0W06 100K J 0402
R6101	Bottom	G	7	0402R	CHIPRES OW06 10K J 0402
R6102	Bottom	Н	7	0402R	CHIPRES JUMPER ORO 0402
R6103	Bottom	G	6	0402R	CHIPRES OW06 22R J 0402
R6104	Bottom	G	7	0402R	CHIPRES JUMPER ORO 0402
R6105	Bottom	G	6	0402R	CHIPRES JUMPER ORO 0402
R7001	Bottom	Т	8	0402R	CHIPRES JUMPER ORO 0402

Item	Side	Grid		Description and value	
R7002	Bottom	Т	8	0402R	CHIPRES JUMPER ORO 0402
R7501	Bottom	R	4	0402R	CHIPRES OW06 2K2 J 0402
R7502	Bottom	S	5	0402R	CHIPRES 0W06 10K F 0402
R7503	Bottom	Q	5	0402R	CHIPRES OW06 4K7 J 0402
R7505	Bottom	R	4	0402R	CHIPRES 0W06 8K2 F 0402
R7506	Bottom	R	5	0402R	CHIPRES OW06 10R J 0402
R7507	Bottom	S	5	0402R	CHIPRES OW06 10R J 0402
R7508	Bottom	R	4	0402R	CHIPRES OW06 10R J 0402
R7509	Bottom	Q	4	0402R	CHIPRES 0W06 22K J 0402
R7510	Bottom	Q	8	0402R	CHIPRES OW06 15R J 0402
R7522	Bottom	Q	8	0402R	CHIPRES 0W06 27K J 0402
R7523	Bottom	S	8	0402R	CHIPRES JUMPER ORO 0402
R7560	Bottom	Q	6	0402R	CHIPRES OW06 100R J 0402
S2401	Bottom	0	1	SWITCH_EVQP7A01K	SM SW TACT SPST 12V SIDE KEY 2.2N
S2402	Bottom	S	1	SWITCH_EVQP7A01K	SM SW TACT SPST 12V SIDE KEY 2.2N
S2403	Тор	U	5	SWITCH_EVQP7A01K	SM SW TACT SPST 12V SIDE KEY 2.2N
T7501	Bottom	R	3	TRANS_HHM1517A2	TRANSF BALUN 3800 +/- 550MHZ 0805
T7520	Bottom	s	9	TRANS_LDB15	TRANSF BALUN 1800+-100MHZ 2X1.25
V2000	Тор	A	4	BGA_4	ASIP TVS BGA4
V2401	Bottom	н	4	SOT_666	TRX2 BIPOLAR 2XPNP 40V 0A1 0W12 SOT666
V2402	Bottom	G	5	SOT_666	TRX2+RX4 N 4K7/47K SOT666
V2405	Тор	G	4	LED_48_21SYGC	LED WHITE 140MCD 5MA 0603
V2406	Тор	G	6	LED_48_21SYGC	LED WHITE 140MCD 5MA 0603
V2407	Тор	C	6	LED_48_21SYGC	LED WHITE 140MCD 5MA 0603
V2409	Тор	C	4	LED_48_21SYGC	LED WHITE 140MCD 5MA 0603
V2410	Bottom	н	4	SC79	SCH DI 1PS79SB31 200MA 30V SOD523
V2411	Bottom	н	4	SOT_666	TRX2 BIPOLAR 2XPNP 40V 0A1 0W12 SOT666
V2412	Bottom	M	1	LED_CL_194WH_D_BIG	LED TOP BLUE 5MA min30mcd 0603 max0.4mm

Item	Side	G	rid	Descript	tion and value
V2413	Bottom	м	9	LED_CL_194WH_D_BIG	LED TOP BLUE 5MA min30mcd 0603 max0.4mm
X1001	Bottom	U	3	CON_24R_JANK_P0.4	CONN BTB 2X12 F P0.4 30V 0.2A
X2000	Bottom	А	7	CON_JACK_HR33NK_2DJA_2 S	CONN CHR DIA 2.0MM COMPRESS
X2002	Bottom	В	3	CON_UX60SC_MB_5ST_1.2L	CONN USB 5POL MINI-USB B TYPE P0.8
X2030	Bottom	В	5	CON_T389093_A1	SMD CONN AUD/VID 4POL 30V 2A, 2.5mm DIA
X2060	Тор	А	3	TRACEABILITY_PAD	MODULE ID COMPONENT 2.8X1.8X0.3
X2070	Bottom	0	3	LYNX_BATT_CONN_H7.0	SM BATTERY CONN 3POL SPR 12V 2A
X2700	Bottom	G	3	SIM_CONN_M_SK_2005001 65_H1.7	CONN SIM SM 6POL P2.54 H1.05
X3200	Bottom	E	7	MOLEX_RSD_501885	CONN SMC TRANSFLASH MMC
X3300	Bottom	Р	5	SMIA85	SMIA85 SOCKET
X7000	Bottom	Т	8	RF_SWITCH_MS_156	SM CONN RF JACK 50R 2W 6GHZ
Z2001	Bottom	с	2	FERRITE_0402	FERRITE BEAD 0.6R 600R/100MZ 0402
Z2400	Bottom	н	4	BGA24_P0.4_H0.67	ASIP 10-CH LCD FILTER W/ESD BGA24
Z2401	Тор	U	4	SWLP_18_2.01X1.66	ASIP 7-CH LCD FILTER W/ESD BGA18
Z2402	Bottom	R	2	SWLP_18_2.01X1.66	ASIP 7-CH LCD FILTER W/ESD BGA18
Z2700	Bottom	н	2	SWLP8_1.21X1.21	ASIP SIM ESD/EMI FILT 400UM BGA8
Z6030	Bottom	R	2	EZFVQ42NM61S	LTCC FILT 2441.75+-41.75MHZ 2.5X2
Z7001	Bottom	т	8	DEA101910DT	PHASESHIFTER-60°@1850 GSM8501900 0402
Z7002	Bottom	т	8	DEA101910DT	PHASESHIFTER-60°@1850 GSM8501900 0402
Z7501	Bottom	s	7	FILTER_2.1X1.7_10P_H0.6	DUAL RX SAW FILTER 1800/1900 MHz 2016
Z7503	Bottom	Q	6	MODULE_SP_LMZ_137	SAW MODULE TX GSM 850/900MHz 4.5x3.2
Z7504	Bottom	R	7	FILTER_2.1X1.7_10P_H0.65	DUAL RX SAW FILTER 850/900 MHz 2016



Item	Side	Grid		Descript	ion and value
Z7520	Bottom	s	7	FERRITE_FBMJ1608	FERRITE BEAD ORO1 28R/100MHZ 0603

Swap units

Table 6 Swap phones

Note: For product codes, please refer to the latest Service bulletin.

Swap phones
EMEA
RM-217 SWAP TRX EURO-C BLKSILVER LATIN
RM-217 SWAP TRX EURO-C FR BLKSILV LATIN
RM-217 SWAP TRX EURO-C TR BLKSILV LATIN
RM-217 SWAP TRX EURO-I UKRAIN BLKSLV CYR
RM-217 SWAP TRX EURO-I RU BLKSILV CYR
RM-217 SWAP TRX MEA-13 BLKSILVER LATIN
RM-217 SWAP TRX EURO-F BLKSILVER HEBREW
RM-217 SWAP TRX EURO-H BLKSILVER GREEK
RM-217 SWAP TRX MEA-1 BLKSILVER ARABIC

Table 7 Lightswap

Note: For product codes, please refer to the latest Service bulletin.

Lightswap
EMEA
RM-217 LIGHTSWAP ENGINE EURO-C
RM-217 LIGHTSWAP ENGINE EURO-C FR
RM-217 LIGHTSWAP ENGINE EURO-C TR LATIN
RM-217 LIGHTSWAP ENGINE EURO-I UKRAI CYR
RM-217 LIGHTSWAP ENGINE EURO-I RU CYR
RM-217 LIGHTSWAP ENGINE MEA-13 LATIN
АРАС
RM-217 LIGHTSWAP ENGINE APAC-U
RM-217 LIGHTSWAP ENG APAC-T PHILLIP LAT
China
RM-217 LIGHTSWAP ENGINE APAC-R
RM-217 LIGHTSWAP ENGINE APAC-P
RM-217 LIGHTSWAP ENGINE CHINA-Q HONGKONG



Component layouts

Component layout - top (1ywa_32a)



Component layout - bottom (1ywa_32a)



Nokia Customer Care

3 — Service Software Instructions



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Phoenix installation steps in brief

Prerequisites

Recommended hardware requirements:

- Computer processor: Pentium 700 MHz or higher
- RAM 256 MB
- Disk space 100-300 MB

Supported operating systems:

- *Windows 2000* Service Pack 3 or higher
- Windows XP Service Pack 1 or higher

Context

Phoenix is a service software for reprogramming, testing and tuning phones.

Phoenix installation contains:

- Service software support for all phone models included in the package
- Flash update package files for programming devices
- All needed drivers for:
 - PKD-1 (DK2) dongle
 - DKU-2 USB cable

Note: Separate installation packages for flash update files and drivers are also available, but it is not necessary to use them unless there are updates between *Phoenix* service software releases. If separate update packages are used, they should be used after *Phoenix* and data packages have been installed.

The phone model specific data package includes all changing product specific data:

- Product software binary files
- Files for type label printing
- Validation file for the faultlog repair data reporting system
- All product specific configuration files for *Phoenix* software components

Note: *Phoenix* and phone data packages should only be used as complete installation packages. Uninstallation should be made from the *Windows* Control Panel.

To use *Phoenix*, you need to:

Steps

- 1. Connect a PKD-1 (DK2) dongle to the computer parallel port.
- 2. Install *Phoenix*.
- 3. Install the phone-specific data package.
- 4. Configure users.
- 5. Manage connection settings (depends on the tools you are using).
 - Update FPS-10 software
 - Note: There is no need to activate FPS-10.
 - Activate SX-4 smart card, if you need tuning and testing functions.

Note: When FPS-10 is used only for product software updates, SX-4 smart card is not needed.

Results

Phoenix is ready to be used with FPS-10 flash prommer and other service tools.

Installing *Phoenix*

Prerequisites

- Check that a dongle is attached to the parallel port of your computer.
- Download the *Phoenix* installation package (for example, *phoenix_service_sw_2004_39_x_xx.exe*) to your computer (in *C:*|*TEMP*, for instance).
- Close all other programs.
- Depending on your operating system, administrator rights may be required to install *Phoenix*.
- If uninstalling or rebooting is needed at any point, you will be prompted by the InstallShield program.

Context

At some point during the installation procedure, you may get the following message:

Dongle n	ot found	×
⚠	Installation cannot continue without a dongle. Insert Nokia dongle and click Retry to re-detect the do or click Cancel to exit the installation.	ngle
	Retry Cancel	<i>b</i>

Figure 2 Dongle not found

This may be a result of a defective or too old PKD-1 dongle.

Check the COM/parallel ports used. After correcting the problem, you can restart the installation.

For more detailed information, please refer to *Phoenix* Help files.

Tip: Each feature in *Phoenix* has its own Help function, which can be activated while running the program. Press the **F1** key or the feature's **Help** button to activate a Help file.

Steps

- 1. To start the installation, run the application file (for example, *phoenix_service_sw_2004_39_x_xx.exe*).
- 2. In the *Welcome* dialogue, click **Next**.

3. Read the disclaimer text carefully and click **Yes**.

Phoenix Service Software - Ins	stallShield Wizard	×
Disclaimer of Warranties		
	Please read the following disclaimer of warranties carefully.	
	DISCLAIMER OF WARRANTIES THE SOFTWARE YOU ARE ABOUT TO INSTALL INCLUDES THIRD PARTY SOFTWARE COMPONENTS (SUCH AS A SMART CARD DRIVER) NOT DEVELOPED BY NOKIA. YOU ACKNOWLEDGE AND AGREE THAT THE THIRD PARTY SOFTWARE COMPONENTS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND EXPRESS OR IMPLIED AND NEITHER NOKIA, ITS LICENSORS OR AFFILIATES MAKE ANY REPRESENTATIONS OR WARRANTIES, EXPRESS OR IMPLIED, INCLUDING BUT NOT LIMITED TO THE WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR THAT THE LICENSED TECHNOLOGY WILL NOT INFRINGE ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADEMARKS, TRADE SECRETS OR ANY OTHER RIGHTS. Do you accept all the terms of the preceding Disclaimer of Warranties? If you select No, the s will close. To Install Phoenix Service Software 2005.04.6.84, you must accept this disclaimer.	× etup
InstallShield	< <u>B</u> ack کوچ <u>N</u>	0

Figure 3 Disclaimer text

4. Choose the destination folder.

The default folder *C: ProgramFiles Nokia Phoenix* is recommended.

5. To continue, click **Next.**

To choose another location, click **Browse** (not recommended).

6. Wait for the components to be copied.

The progress of the installation is shown in the *Setup Status* window.

7. Wait for the drivers to be installed and updated.

The process may take several minutes to complete.

If the operating system does not require rebooting, the PC components are registered right away. If the operating system requires restarting your computer, the Install Shield Wizard will notifies about it. Select **Yes...** to reboot the PC immediately or **No...** to reboot the PC manually afterwards. After the reboot, all components are registered.

Note: *Phoenix* does not work, if the components have not been registered.

8. To end the installation, click **Finish**.

Phoenix Service Software Setup	
	InstallShield Wizard Complete
	The InstallShield Wizard has successfully installed Phoenix Service Software A. Click Finish to exit the wizard.
	✓ Add Phoenix icon to Desktop.
InstallShield	K Back Finish Cancel

Figure 4 InstallShield Wizard Complete

Next actions

After the installation, *Phoenix* can be used after:

- installing phone model specific data package for *Phoenix*
- configuring users and connections

FPS-10 flash prommer can be used after updating their flash update package files.

Updating *Phoenix* installation

Context

- If you already have the *Phoenix* service software installed on your computer, you need to update the software when new versions are released.
- To update *Phoenix*, you need to follow the same steps as when installing it for the first time.
- When you are updating, for example, from version **a14_2004_16_4_47** to **a15_2004_24_7_55**, the update will take place automatically without uninstallation.
- Always use the latest available versions of both *Phoenix* and the phone-specific data package. Instructions can be found in the phone model specific Technical Bulletins and phone data package *readme.txt* files (shown during installation).
- If you try to update *Phoenix* with the same version you already have (for example, **a15_2004_24_7_55** to **a15_2004_24_7_55**), you are asked if you want to uninstall the existing version. In this case you can choose between a total uninstallation or a repair installation in a similar way when choosing to uninstall the application from the *Windows* Control Panel.
- If you try to install an older version (for example, downgrade from **a15_2004_24_7_55** to **a14_2004_16_4_47**), installation will be interrupted.



Figure 5 Installation interrupted

• Always follow the instructions on the screen.

Steps

- 1. Download the installation package to your computer hard disk.
- 2. Close all other programs.
- 3. Run the application file (for example, *phoenix_service_sw_2004_39_x_xx.exe*).

Results

A new *Phoenix* version is installed and driver versions are checked and updated.

Uninstalling *Phoenix*

Context

You can uninstall *Phoenix* service software manually from the *Windows* Control Panel.

Steps

1. Open the **Windows Control Panel**, and choose **Add/Remove Programs**.

2. To uninstall *Phoenix*, choose **Phoenix Service Software** \rightarrow **Change/Remove** \rightarrow **Remove**.



Figure 6 Remove program

The progress of the uninstallation is shown.

3. If the operating system does not require rebooting, click **Finish** to complete.



Figure 7 Finish uninstallation

If the operating system requires rebooting, InstallShield Wizard will notify you. Select **Yes...** to reboot the PC immediately and **No...** to reboot the PC manually afterwards.

Repairing *Phoenix* installation

Context

If you experience any problems with the service software or suspect that files have been lost, use the repair function before completely reinstalling *Phoenix*.

Note: The original installation package (for example, *phoenix_service_sw_a15_2004_24_7_55.exe*) must be found on your PC when you run the repair setup.

Steps

- 1. Open Windows Control Panel → Add/Remove Programs .
- 2. Choose Phoenix Service Software → Change/Remove.
- 3. In the following view, select **Repair**.



Figure 8 Repair program

Phoenix reinstalls components and registers them.

The procedure is the same as when updating *Phoenix*.

4. To complete the repair, click **Finish**.

Phone data package overview

Each product has its own data package (DP). The product data package contains all product-specific data files to make the Phoenix service software and tools usable with a certain phone model.

The phone data package contains the following:

• Product software binary files

- Files for type label printing
- Validation file for the fault log repair data reporting system
- All product-specific configuration files for Phoenix software components

Data files are stored in C:\Program Files\Nokia\Phoenix (default).

Installing phone data package

Prerequisites

- A phone-specific data package contains all data required for the *Phoenix* service software and service tools to be used with a certain phone model.
- Check that a dongle is attached to the parallel port of your computer.
- Install *Phoenix* service software.
- Download the installation package (for example, *XX-XX_dp_EA_v_1_0.exe*) to your computer (for example, in C:\TEMP).
- Close all other programs.

(XX-XX = type designator of the product)

If you already have *Phoenix* installed on your computer, you will need to update it when a new version is released.

Note: Often *Phoenix* and the phone-specific data package come in pairs, meaning that a certain version of *Phoenix* can only be used with a certain version of a data package. Always use the latest available versions of both. Instructions can be found in phone-specific Technical Bulletins and *readme.txt* files of data packages.

Steps

1. To start the installation, run the application file (for example, *XX-XX_dp_EA_v_1_0.exe*), Wait for the installation files to be extracted.

2. Click **Next**.

Phone Data Package Setup		×
	Welcome to the InstallShield Wizard for Phone Data Package	
	The InstallShield® Wizard x.x will update xx-xxPhone Data Package to version x.x. To continue, click Next.	
	< Back Next > Cancel	

3. In the following view you can see the contents of the data package. Read the text carefully. There is information about the *Phoenix* version required with this data package.

Phone Data Package Setup
Information Please read the following text.
To start installing the files, click Next.
Phone Data Fackage xx x Installation (mcusw 3.42 Customer Care/Production)
Note !! VERY IMPORTANT:
You need to uninstall the previous version of the data package before installing this version. It will NOT work correctly if this step is skipped.
Close Phoenix before starting installation of the Data Package.
Note! Phoenix release A 200xx x xx or newer is required! earlier versions may work
Installbhreid Kancel

Figure 9 Data package setup information

4. To continue, click **Next**.

5. Choose the destination folder, and click **Next** to continue.

Phone Data Package Setup	×
Choose Destination Location Select folder where setup will install files.	
Setup will install xx-xx Phone Data Package in the follo	wing folder.
To install to this folder, click Next. To install to a differen another folder.	t folder, click Browse and select
Destination Folder C:\Program Files\Nokia\Phoenix	Browse
InstallShield	
< B-	ack Next> Cancel

Figure 10 Data package destination folder

The InstallShield Wizard checks where *Phoenix* is installed, and the directory is shown.

6. To start copying the files, click **Next**.

Phone Data Package Setup			×
Start Copying Files			No.
To star: installing the files, click Next.			
Current Settings:			
Installation path: C:\Program Files\Nokia\Pho	enix		×
InstallShield			
instalionielu.	< Back	Next >	Cancel

Phone model specific files are installed. Please wait.

7. To complete the installation, click **Finish**.

Phone Data Package Setup	
	InstallShield Wizard Complete The InstallShield Wizard has successfully installed xx-xx Phone Data Package. Click Finish to exit the wizard.
	< Back Finish Cancel

Figure 11 InstallShield Wizard Complete

Next actions

Phoenix can be used for flashing phones and printing type labels after:

- Configuring users
- Managing connections

FPS-10 can be used after updating their flash update package files.

Uninstalling phone data package

Context

There is no need to uninstall an older version of a data package, unless instructions to do so are given in the *readme.txt* file of the data package and bulletins related to the release.

Please read all related documents carefully.

Steps

- 1. Locate the data package installation file (e.g. *XX-XX_dp_EA_v_1_0.exe*) from your computer.
- 2. To start the uninstallation procedure, double-click the data package installation file.

3. To uninstall the data package, click **OK** or to interrupt the uninstallation, click **Cancel**.



Figure 12 Uninstalling phone data package

4. When the data package is uninstalled, click **Finish**.

Phone Data Package Setup	
	Uninstallation complete InstallShield Wizard has completed the uninstallation of xx-xx Phone Data Package. Click Finish to exit the wizard.
	K Back Finish Canool

Figure 13 Finishing data package uninstallation

Alternative steps

 You can also uninstall the data package manually from Control Panel→Add/Remove Programs→xx-xx* Phone Data Package . (*= type designator of the phone).

Configuring users in *Phoenix*

Steps

1. Start *Phoenix* service software, and log in.

Login			? ×
User			
User name:			
TU (Test U:	ser)		•
			Maintain
	Ok	Cancel	Help

Figure 14 Phoenix login

If the user ID is already configured, select s/he from the *User name* drop-down list, and click **OK**.

- 2. To add a new user, or to edit existing ones, click **Maintain**.
- 3. To add a new user, click **New**.
- 4. Type in the name and initials of the user, and click **OK**. The user is added to the user name list.
- 5. Select the desired user from the *User name* drop-down list, and click **OK**.

Login					<u>?</u> ×
User					
User name:					
RT (Repair	Technician)				•
			[Maintain	
	Ok	С	ancel	Help	

Figure 15 New user configured

Managing connections in *Phoenix*

Context

With the **Manage Connections** feature you can edit and delete existing connections or create new ones.

Note: After choosing the desired connection, and connecting the phone to a PC for the first time, allow the PC to install the USB device drivers first. Please note that this may take some time to complete.

If there are problems after the driver installation, check that the USB connection is active from the **Windows Control Panel**. If the problem persists, contact the local PC support.

Steps

- 1. Start *Phoenix*, and log in.
- 2. Choose File \rightarrow Manage Connections....

3. To add a new connection, click **Add**.

Manage Conne	ection				
Priority list:	ION				
					-
					el.
					<u> </u>
Add	Delete	Edit	Apply	Close	<u>H</u> elp

4. Select **Manual** mode, and click **Next** to continue.

If you want to create the connection using the Connection Wizard, connect the tools and a phone to your PC. The wizard will automatically try to configure the correct connection.

Mode				_	
C Wizard					
Select mode	to use. If your s	system has a co	nnection		
wizard instal	ed you can use e to use manua	it to add a con Il mode.	nection,		
wizard instal else you hav	ed you can use re to use manua	it to add a con Il mode.	nection,		
wizard instal else you hav	ed you can use re to use manua	it to add a con Il mode.	nection,		

Figure 16 Select mode: Manual

- i For an FPS-10 flash prommer with a **USB Connection**, choose the following connection settings:
 - Media: FPS-10 USB
 - DEVICE_INDEX: 0
 - SERIAL_NUM: See Serial No from the label attached to the bottom of FPS-10
 - ACTIVE_MEDIA: USB

ii For an FPS-10 flash prommer with a **LAN connection**, choose the following connection settings:

- Media: FPS-10 TCP/IP
- NET_SERV_NAME: Click **Scan...**. Choose your own FPS-10 device based on the correct MAC address. See Serial No from the label attached to the bottom of your FPS-10.
- PORT_NUM: Use the default value, and click **Next**.
- PROTOCOL_FAMILY: Use the default value, and click **Next**.
- SOCKET TYPE: Use the default value, and click **Next**.
- TX_BUFFER_SIZE: Use the default value, and click **Next**.
- RX_BUFFER_SIZE: Use the default value, and click **Next**.
- iii For an FPS-8 flash prommer, choose the following connection settings:
 - Media: FPS-8
 - PORT_NUM: COM Port where FPS-8 is connected
 - COMBOX_DEF_MEDIA: FBUS

- iv For a plain **USB connection**, choose the following connection settings:
 - **Note:** First connect the DKU-2 USB cable between the PC USB port and phone.
 - Media: USB
- 5. To complete the configuration, click **Finish**.
- 6. Click the connection you want to activate. Use the up/down arrows located on the right hand side to move it on top of the list, then click **Apply**.

🔏 Manage Connection	
Priority list:	
FPS-10 USB (USB) NO CONNECTION	
Add Delete Edit Apply Close	Help

Figure 17 Connections list

The connection is activated, and it can be used after closing the *Manage Connection* window. The connection information is shown at the right hand bottom corner of the screen.



Figure 18 Connection information

7. To use the connection, connect the phone to your PC with correct service tools. Make sure the phone is switched on, and then choose **File**→**Scan Product**.

Results

The product support module information appears in the status bar:

V 2.0436v19.1 , 18-10-04 , RM-1 , (c) NOKIA. / V 2.39.126 , 18-10-04 , RM-1 , (c)

Figure 19 Product support module information (example from RM-1)

Installing flash support files for FPS-10

Prerequisites

Note: You need to install flash support files for FPS-10 only, if you don't have the latest Phoenix available or the flash support files have changed after the latest Phoenix release.

- Flash support files are installed automatically, when you install Phoenix. Use Phoenix packages later than June 2006.
- Normally it is enough to install Phoenix and the phone-specific data package because the Phoenix installation always includes the latest flash update package files for FPS-10.
- A separate installation package for flash support files is available, and the files can be updated according to this instruction, if updates appear between new Phoenix / data package releases

Context

If you are not using a separate installation package, you can skip this section and continue with updating FPS-10 flash prommer software after installing a new phone data package.

Steps

1. To begin installation, double- click *flash_update_x_yy.exe*.



Figure 20 Flash update welcome dialog

If the same version of Flash Update package already exists, and you want to reinstall it, the previous package is first uninstalled. Restart installation again after that.

2. If you try to downgrade the existing version to older ones, the setup will be aborted. If you really want to downgrade, uninstall newer files manually from **Control Panel** and then rerun the installation again.

Flash Up	date - InstallShield Wizard
8	You have newer version 03.18.004 of the application. If you want to install older version 03.18.003 you need to uninstall the current version before.
	Setup will exit.

Figure 21 Flash installation interrupted

If an older version exists on your PC and it needs to be updated, click **Next** to continue installation.

3. It is highly recommended to install the files to the default destination folder *C:*|*Program Files*|*Nokia* |*Phoenix*. Click **Next** to continue.

Flash Update - InstallShield Wiz	ard	×
Choose Destination Location Select folder where setup will in:	tall files.	
	Setup will install Flash Update 03.18.004 in the following folder.	
	To install to this folder, click Next. To install to a different folder, click Browse and select another folder.	
	–Destination Folder– C:\Program Files\Nokia\Phoenix B <u>rowse</u>]
InstallShield	< Back Cancel	

Figure 22 Flash destination folder

When installing the flash update files for the first time you may choose another location by selecting **Browse**. However, this is not recommended.

4. To complete the installation procedure, click **Finish** .

Flash Update - InstallShield Wiza	ard
	InstallShield Wizard Complete
	The InstallShield Wizard has successfully installed Flash Update 0318.004. Click Finish to exit the wizard.
InstallShield	< Back Finish Cancel

Figure 23 Finish flash update

Next actions

FPS-10 flash prommers must be updated using Phoenix!

Updating FPS-10 flash prommer software

Steps

- 1. Start *Phoenix Service Software* and log in, manage connection correctly for your flash prommer.
- 2. Choose **Flashing**→**Prommer maintenance**.
- 3. When the new flash update package is installed to the computer you will be asked to update the files to your Prommer. To update the files, click **Yes**. Click **OK** if the computer informs you about an unsafe removal of the device.
- 4. Alternatively you can update the FPS-10 flash prommer software by clicking the **Update** button.

5. Wait until you are notified that update has been successful; the procedure will take a couple of minutes. Click **OK** to close the *Update Done* window.

😻 🖪 Updal	te Done	x
•	Prommer SW updated succesfully.	
	СК	

Figure 24 Prommer SW update finished

- 6. If you are using the FPS-10 flash prommer, check that it is detected from the progress info. Check also the status leds in the FPS-10. The MODE2 led (green), VBAT and POWER leds (red) should be lit. If you are using LAN connection, the LAN led (yellow) should be blinking.
- 7. Check that your FPS-10 flash prommer has enough memory. Flashing the SU-18 with FPS-10 needs at least 128 MB of SRAM memory in the prommer.

N	00E0031329BC	File name	Туре	File ID	Version	Size	
		h3_sam_nand_gbbm.fg	Algo	1	001.018.000		
N	9	h3_sam_nand_xsr.fg	Algo	2	001.018.000		
19720	10000004	h3_sam_nand_xsr_sm	Algo	3	001.017.000		
ash Size	124386304	RAP3Gv3_algo.fg	Algo	4	001.008.001		
- EL-1-(L-)	110469622	te_essr.fia	Algo	5	004.043.000		
ee Flash (D)	1110403032	te_amd.fia	Algo	6	004.043.000		
AM Size	134217728	te_amd_b.fia	Algo	7	004.043.000		
AM 5126		t2_amd.fia	Algo	8	004.043.000		
e SRAM (b)	117649408	t2_amd_b.fia	Algo	9	004.043.000		
		w3_amd.fia	Algo	10	004.043.000		
ot SW	V B1.7.0 16-05-2	s3_amd_b.fia	Algo	11	004.043.000		
		w2_amd.fia	Algo	12	004.043.000		
GA	V C1.7.0 16-05-2	s2_amd_b.fia	Algo	13	004.043.000		
	VA1 70 10050	w3_amd_b.fia	Algo	14	004.043.000		
plication SW	VA1.7.0 16-05-2	w2_amd_b.fia	Algo	15	004.043.000		
Kr	TEST OK	te_intel.fia	Algo	16	004.043.000		
intest status	TESTOR	Ite int hifa	Alan	17	004 043 000		
	0.0.0.0						
	· · · · ·						
ogress Info							
inishing file up	load 0%						
ile unload finis	bed 100%						
rommer updat	ed successfully. Time t	aken:2 min 55 sec					
nitializing							
PS10 detecte	d based on connection	settings					

Figure 25 Prommer maintenance window

Alternative steps

• You can update FPS-10 SW by clicking the **Update** button and selecting the appropriate fpsxupd.ini file in *C*: *Program Files Nokia Phoenix Flash*.

Open					? ×
Look in:	🔁 Flash		•	🗢 🗈 💣 🎫	
History Desktop My Computer	0.3.09.002 5.002 5.002 5.002 5.002 5.002				
	File name:	fps8upd.ini		-	Open
	Files of type:	Ini files (*.ini)		•	Cancel

Figure 26 Flash directory window

• All files can be loaded separately to the prommer used. To do this, click the right mouse button in the *Flash box files* window and select the file type to be loaded.

More information can be found in Phoenix **Help**.
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4 — Service Tools and Service Concepts



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Service tools

Product specific tools

The table below gives a short overview of service tools that can be used for testing, error analysis and repair of product RM-217; RM-222, refer to various concepts.

The I de	FS-	47		Flash ac	lapter		
	For flashing (also dead phones) with SS-64. RF testing and tuning, and EM calibration on ATO level with SS-62 (mechanical locking concept), CU-4 supported.						
	MJ	-122		Module	jig		
	MJ- the	-122 is meant f e engine level (for tro (CU-4	oubleshoo supporte	oting, testing, 1 d).	tuni	ng and flashing on
	Th	e jig includes a	n RF	interface	for GSM and Bl	ueto	ooth.
	Th coi	e following tat nnetion:	ole sh	ows the a	attenuation val	lues	for galvanic RF
				•		2	
	•	Band	ch	uning Iannel	Attenuation	KX	Attenuation TX
	•	Band GSM850	ch 190	annel	Attenuation 0,1	RX	Attenuation TX 0,1
	•	GSM850 GSM900	190 37	uning iannel	0,1 0,1	RX	Attenuation TX 0,1 0,1
	•	Band GSM850 GSM900 GSM1800	ch 190 37 700	annel	Attenuation 0,1 0,1 0,15	KX	Attenuation TX 0,1 0,1 0,15
	•	Band GSM850 GSM900 GSM1800 GSM1900	ch 190 37 700 661	annel	Attenuation 0,1 0,1 0,15 0,15		Attenuation TX 0,1 0,1 0,15 0,15
	• RJ-	Band GSM850 GSM900 GSM1800 GSM1900 148	ch 190 37 700 661	Solderin	Attenuation 0,1 0,1 0,15 0,15 ng jig		Attenuation TX 0,1 0,1 0,15 0,15



SA-123					
	RF coupler	·			
SA-123 IS all RF CO	upler for GSM RF lash adapter.	testing. It is use	d together with th		
The following tab	The following table shows attenuations from the antenna pads of the				
mobile terminal t	mobile terminal to the SMA connectors of SA-123:				
• Nokia 6300 (R	M-217)				
Band	Channel	Tx-att. (dB)	Rx-att. (dB)		
EGSM 900	975	5,6	6		
	38	5,2	7		
	124	5,2	7		
GSM 1800	512	7,3	10		
	698	8,2	10		
	885	8,1	10		
GSM 1900	512	8,6	9		
	661	8,7	7		
	810	9,1	7		
Tx-attenuation to	lerance is +/-0.5	dB	<u> </u>]		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (lerance is +/-0.5 lerance is +/-1.0 [RM-222)	dB dB			
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band	lerance is +/-0.5 lerance is +/-1.0 [RM-222] Channel	dB dB Tx-att. (dB)	Rx-att. (dB)		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band GSM 850	lerance is +/-0.5 lerance is +/-1.0 [RM-222] Channel 128	dB dB Tx-att. (dB) 8,1	Rx-att. (dB) 9		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band GSM 850	lerance is +/-0.5 lerance is +/-1.0 [RM-222) Channel 128 190	dB dB Tx-att. (dB) 8,1 7,4	Rx-att. (dB) 9 9		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band GSM 850	lerance is +/-0.5 lerance is +/-1.0 (RM-222) Channel 128 190 251	dB dB Tx-att. (dB) 8,1 7,4 7,7	Rx-att. (dB) 9 9 10		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band GSM 850 GSM 1800	lerance is +/-0.5 lerance is +/-1.0 (RM-222) Channel 128 190 251 512	dB dB Tx-att. (dB) 8,1 7,4 7,7 8,6	Rx-att. (dB) 9 9 10 7		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band GSM 850 GSM 1800	lerance is +/-0.5 lerance is +/-1.0 (RM-222) (Channel 128 190 251 512 698	dB dB Tx-att. (dB) 8,1 7,4 7,7 8,6 8,7	Rx-att. (dB) 9 9 10 7 8		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band GSM 850 GSM 1800	lerance is +/-0.5 lerance is +/-1.0 (RM-222) (Channel 128 190 251 512 698 885	dB dB Tx-att. (dB) 8,1 7,4 7,7 8,6 8,7 7,5	Rx-att. (dB) 9 9 10 7 8 6		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band GSM 850 GSM 1800 GSM 1900	lerance is +/-0.5 lerance is +/-1.0 (RM-222) (Channel 128 190 251 512 698 885 885 512	dB dB dB 7,4 7,7 8,6 8,7 7,5 6,7	Rx-att. (dB) 9 9 10 7 8 6 8 8 8 8 8 8 8		
Tx-attenuation to Rx-attenuation to • Nokia 6300b (Band GSM 850 GSM 1800 GSM 1900	lerance is +/-0.5 lerance is +/-1.0 (RM-222) (Channel 128 190 251 512 698 885 885 512 661	dB dB dB 7,4 7,7 8,6 8,7 7,5 6,7 6,1	Rx-att. (dB) 9 9 10 7 8 6 8		

	SS-101	Domesheet alignment jig	
62222 C	The purpose of this to to the PWB.	ol is to support the place	ement of a domesheet

General tools

The table below gives a short overview of service tools that can be used for testing, error analysis and repair of product RM-217; RM-222, refer to various concepts.



NOKIA

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FLS-4S	Flash device	
FLS-4S is a dongle and developed specifically	flash device incorporate for POS use.	ed into one package,
FLS-5	Flash device	
FLS-5 is a dongle and f developed specifically	lash device incorporated for POS use.	d into one package,
FPS-10	Flash prommer	
 FPS-10 interfaces with PC Control unit Flash adapter Smart card FPS-10 flash prommer Flash functionality f Smart Card reader f USB traffic forwardi USB to FBUS/Flashb LAN to FBUS/Flashb Vusb output switch FPS-10 sales package i FPS-10 prommer Power Supply with USB cable 	: features: for BB5 and DCT-4 termin or SX-2 or SX-4 ng us conversion us and USB conversion able by PC command ncludes: 5 country specific cords	nals



NORTH OF	JBT-9 The JBT-9 test box is a Bluetooth bit error rat connection via Bluetoo and an AXS-4 cable in o Sales package includes • JBT-9 test box	Bluetooth test and interface box (sales package) generic service device u e (BER) testing, and esta oth. An ACP-8x charger is case of cordless interfact	sed to perform blishing cordless FBUS needed for BER testing e usage testing .
	 Installation and wa PK-1 PK-1 is a hardware prof functionality as the PK PK-1 is meant for use value To use this USB dongle the dongle in the same 	rranty information Software protection key tection key with a USB in D-1 series dongle. with a PC that does not h e for security service fun- e way as the PKD-1 serie	terface. It has the same nave a series interface. ctions please register s dongle.
	PKD-1 SW security device is a service software when Without the device, it Printer or any such device device if needed.	SW security device piece of hardware enat connected to the parall is not possible to use th vice can be connected to	oling the use of the lel (LPT) port of the PC. e service software. o the PC through the
	RJ-93 RJ-93 is used as a rewo This stencil takes the f module for spreading used together with the	Rework jig ork jig for the engine mo ront end module (FEM) o the soldering paste to th e ST-40 stencil.	odule. or power amplifier (PA) ne component. Must be
	SPS-1	Soldering Paste Spreader	



SRT-6	Opening tool		
SRT-6 is used to open	ohone covers and B-to-E	3 connectors.	
SS-45	Front camera removal tool		
The front camera remo front camera module f	oval tool SS-45 is used to rom/to the socket.	o remove/attach the	
SS-46	Interface adapter		
SS-46 acts as an interfa FPS-10.	ace adapter between th	e flash adapter and	
SS-62	Generic flash adapter base for BB5		
 generic base for flash adapters and couplers SS-62 equipped with a clip interlock system provides standardised interface towards Control Unit provides RF connection using galvanic connector or coupler multiplexing between USB and FBUS media, controlled by VUSB 			
ST-40	rework stencil		
ST-40 is a rework sten	cil and used with RJ-93.		



	SX-4	Smart card			
-	SX-4 is a BB5 security device used to protect critical features in tuning and testing.				
	SX-4 is also needed too flashed.	gether with FPS-10 whe	n DCT-4 phones are		

Cables

The table below gives a short overview of service tools that can be used for testing, error analysis and repair of product RM-217; RM-222, refer to various concepts.

CA-31D	USB cable		
The CA-31D USB cable is used to connect FPS-10 or FPS-11 to a PC. It is included in the FPS-10 and FPS-11 sales packages.			
CA-35S	Power cable		
CA-35S is a power cabl prommer to the Point-	e for connecting, for exa Of-Sales (POS) flash ada	ample, the FPS-10 flash pter.	
DAU-9S	MBUS cable		
The MBUS cable DAU-9 example, between the or docking station ada Note: Docking	S has a modular connect PC's serial port and mod pters. 9 station adapters valid	tor and is used, for dule jigs, flash adapters for DCT4 products.	



A starting the starting starti	DKE-2	Mini-USB cable	
	USB to mini-USB conne	ctor cable.	
	PCS-1	Power cable	
	The PCS-1 power cable jig or a control unit to	(DC) is used with a doc supply a controlled ope	king station, a module rating voltage.
	XCS-4	Modular cable	
	XCS-4 is a shielded (on for flashing and servic	e specially shielded con e purposes.	ductor) modular cable
	XRE-2	Bluetooth cable	
	The bluetooth cable co jig to the bluetooth te	onnects the bluetooth co st box JBT-9.	onnector of the module



XRS-6	RF cable	
The RF cable is used to the RF measurement e SMA to N-Connector ap	o connect, for example, a equipment. oproximately 610 mm.	a module repair jig to
Attenuation for: • GSM850/900: 0.3+-(• GSM1800/1900: 0.5 • WLAN: 0.6+-0.1dB).1 dB +-0.1 dB	

Service concepts

POS (Point of Sale) flash concept





Туре	Description
Product specific tools	
BL-4C	Battery
Other tools	
ACP-8	Power adapter
FLS-4S or FLS-5	POS flash dongle



Туре	Description
	PC with Phoenix service software
Cables	
DKE-2	USB connectivity cable

Flash concept with FPS-10



Figure 28 Basic flash concept with FPS-10

Туре	Description	
Product spe	Product specific tools	
FS-47	Flash adapter	
Other tools		
FPS-10	Flash prommer box	
PKD-1/PK-1	SW security device	
SS-46	Interface adapter	
	PC with Phoenix service software	
Cables		
XCS-4	Modular cable	
CA-35S	Power cable	





Туре	Description
	USB cable

CU-4 flash concept with FPS-10





Туре	Description	
Product spe	Product specific tools	
FS-47	Flash adapter	
Other tools		
CU-4	Control unit	
FPS-10	Flash prommer box	
PKD-1/PK-1	SW security device	
SS-62	Flash adapter base	
SX-4	Smart card	
	PC with Phoenix service software	
Cables		
PCS-1	Power cable	
XCS-4	Modular cable	
	Standard USB cable	



Туре	Description
	USB cable

Module jig service concept



Figure 30 Module jig service concept

Туре	Description	
Phone speci	Phone specific tools	
MJ-122	Module jig	
Other tools		
CU-4	Control unit	
FPS-10	Flash prommer box	
PKD-1/PK-1	SW security device	
SX-4	Smart card	
	PC with Phoenix service software	
	Measurement equipment	
Cables		
PCS-1	DC power cable	
XCS-4	Modular cable	



Туре	Description
XRS-6	RF cable
	USB cable
	GPIB control cable

RF testing concept with RF coupler



Figure 31 RF testing concept with RF coupler

Туре	Description
Product spe	cific tools
FS-47	Flash adapter
SA-123	RF coupler
Other tools	
CU-4	Control unit
SX-4	Smart card
FPS-10	Flash prommer box
PKD-1/PK-1	SW security device
SS-62	Flash adapter base
	Measurement equipment
	PC with Phoenix service software

Туре	Description
Cables	
PCS-1	Power cable
XCS-4	Modular cable
XRS-6	RF cable
	GPIB control cable
	USB cable

Service concept for RF testing and RF/BB tuning



Figure 32 Service concept for RF testing and RF/BB tuning

Туре	Description
Product specific tools	
MJ-122	Module jig
Other tools	
CU-4	Control unit
SX-4	Smart card
	Measurement equipment
	Smart card reader

Туре	Description
	PC with Phoenix service software
Cables	
DAU-9s	MBUS cable
PCS-1	DC power cable
PKD-1/PK-1	SW security device
XRS-6	RF cable
	GPIB control cable
	USB cable

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5 — Disassembly and reassembly instructions

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Disassembly instructions



1. Needed tools: SRT-6, metal tweezers, SS-93, SS-45 camera removal tool, a straight bladed screwdriver, dental pick, bit holder with a torx plus size 6 bit, a torque driver, DC plug



2. Always cover the windows with a protective film.





5. Remove the screws.



RM-217; RM-222 Disassembly and reassembly instructions



















Note: Antenna Module is marked 850 or 900 to enable identification of different versions by regions.



Assembly hints









RM-217; RM-222 Disassembly and reassembly instructions



Note: Antenna Module is marked 850 or 900 to enable identification of different versions by regions.

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6 — BB Troubleshooting and Manual Tuning Guide
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Baseband troubleshooting overview

This section is intended to be a guide for localising and repairing electrical faults. The table below tells you what troubleshooting to go to.

Problem	Troubleshooting
Abnormal current consumption	1 General power checking (page 6–6)
	2 Battery current measuring fault (page 6–7)
Flashing does not work or the problem is not clearly	1 Flashing (page 6–15)
defined	2 Clocking (page 6–9)
	3 Combo memory (page 6–14)
Charging does not work	Charging (page 6–8)
Display does not work	Display fault (page 6–20)
Backlights do not work	1 Backlight (page 6–23)
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Audio (mic, earpiece, IHF) does not work	1 Audio (page 6–26)
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	2 Camera viewfinder (page 6–12)
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Bluetooth does not work	Bluetooth (BT) (page 6–37)
FM radio does not work	FM radio (page 6–17)
MicroSD card does not work	MicroSD card (page 6–18)

Power and charging troubleshooting

General power checking troubleshooting





Battery current measuring fault troubleshooting



Charging troubleshooting



Clocking troubleshooting



Interface troubleshooting

Camera failure

Introduction to camera troubleshooting

Bad conditions often cause bad pictures. Therefore, the camera operation has to be checked in constant conditions or by using a second, known-to-be-good Nokia device as reference. Image quality is hard to measure quantitatively, and the difference between a good and a bad picture can be small. Some training or experience may be needed to detect what is actually wrong.

When checking for possible errors in camera functionality, knowing what error is suspected significantly helps the testing by narrowing down the amount of test cases. The following types of image quality problems are common:

- Dust (black spots)
- Lack of sharpness
- Bit errors

Taking and evaluating test pictures

When *taking* a test picture, remember the following:

- Avoid bright fluorescent light, 50/60Hz electrical network or high artificial illumination levels
- If the phone is hot, let it rest for a while before taking the picture
- Make sure the optical system is clean
- Use highest possible resolution
- Make sure the light is suffiecient (bright office lightning)
- Do not take the picture towards light source
- Be as still as possible when taking the picture
- Distance should be at least 40cm, 1-2m is recommended

When *evaluating* a test picture, remember the following:

- The center of the picture is sharper than the edges
- The image may be blurred, though it does not show in the viewfinder
- Analyse the picture from your PC monitor, full colour setting is recommended
- If possible, compare with a picture of the same motive taken with a similar Nokia device

Camera hardware troubleshooting



Camera viewfinder troubleshooting



Camera: Bad image quality troubleshooting



COMBO memory troubleshooting



Flash programming fault troubleshooting

Part 1



Part 2



Figure 33 Flashing pic 1. Take single trig measurement for the rise of the BSI signal.



Figure 34 Flashing pic 2. Take single trig measurement for the rise of the BSI signal.

FM radio troubleshooting





MicroSD card troubleshooting

Context

In the RM-217/222 the microSD card reader is located under the battery cover.







Take single trig measurement on the rising edge of the DAT signal.

Figure 36 SD card initialization from pin J3206

User interface troubleshooting

Display module troubleshooting

General instructions for display troubleshooting

Context

The RM-217/222 has three display modes:

- *Normal mode*: The display is in normal mode when the phone is in active use.
- *Partial idle mode*: The display is in partial idle mode when the power saver is on.
- *Sleep mode*: The display has a sleep mode to conserve power. In this mode the display looks blank, but the phone is switched on. To verify if the phone display is sleeping, press a key.

The operating modes of the display can be controlled with the phone settings menu.

Display blank	There is no image on the display. The display looks the same when the phone is on as it does when the phone is off. The backlight can be on in some cases.
Image on the display not correct	Image on the display can be corrupted or a part of the image can be missing. If a part of the image is missing, change the display module. If the image is otherwise corrupted, follow the appropriate troubleshooting diagram.
Backlight dim or not working at all	Backlight LED components are inside the display module. Backlight failure can also be in the connector or in the backlight power source in the main engine of the phone. This means that in case the display is working (image OK), the backlight is faulty.

Table 8 Display module troubleshooting cases

Visual defects (pixel)	Pixel defects can be checked by controlling the display with Phoenix. Use both colours, black and white, on a full screen.
	The display may have some random pixel defects that are acceptable for this type of display. The criteria when pixel defects are regarded as a display failure, resulting in a replacement of the display, are presented the following table.

Table 9 Pixel defects

Item			White dot defect				Total
1	Defect counts	R	G	В	White Dot Total	1	1
		1	1	1	1		
2	Combined defect counts	Not allowe Two single interprete	ed. e dot defect ed as combii	s that are w ned dot defe	rithin 5 mm c ect.	of each other	should be

Steps

- 1. Verify with a working display that the fault is not on the display module itself. The display module cannot be repaired.
- 2. Check that the cellular engine is working normally.
 - i To check the functionality, connect the phone to a docking station.
 - ii Start*Phoenix* service software.
 - iii Read the phone information to check that also the application engine is functioning normally (you should be able to read the APE ID).
- 3. Proceed to the display troubleshooting flowcharts.

Use the **Display Test** tool in *Phoenix* to find the detailed fault mode.

Display troubleshooting

Troubleshooting flow



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Backlight troubleshooting

Context

The device has one LED driver that provides current for both the display and keyboard backlights. Brightness can be adjusted manually, and it affects both the display and keypad. Keyboard backlights can be turned ON/ OFF separately but not without switching on the display lights.

Display and keyboard backlight troubleshooting



Reminder LED troubleshooting



LED driver troubleshooting

LED driver troubleshooting





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Audio troubleshooting

Introduction to acoustics troubleshooting

Note: Always make sure all openings are clean and all contact pads are intact and make contact. If audio still does not work, please continue to the electronic audio troubleshooting (2nd diagram where applicable).

Acoustics design ensures that the sound is detected correctly with a microphone and properly radiated to the outside of the device by speaker(s). The acoustics of the phone includes three basic systems: earpiece, Integrated Hands Free (IHF) and microphone.

The sound reproduced from the earpiece readiates through a single hole on the front cover (A-cover). The sound reproduced from the IHF speaker radiates from a single sound hole located 3 cm below the power key. The microphone is located at the hinge, next to the system connector.

For a correct functionality of the phone, all sound holes must be always open. When the phone is used, care must be taken not to close any of those holes with a hand or fingers. The phone should be dry and clean, and no objects must be located in such a way that they close any of the holes.

Audio troubleshooting test instructions

Differential internal earpiece outputs can be measured either with a single-ended or a differential probe.

When measuring with a single-ended probe each output is measured against the ground.

Internal handsfree output is measured using a current probe, if a special low-pass filter designed for measuring a digital amplifier is not available. Note also that when using a current probe, the input signal frequency must be set to 2kHz.

The input signal for each loop test can be single-ended.

Required equipment

The following equipment is needed for the tests:

- Oscilloscope
- Function generator (sine waveform)
- Current probe (Internal handsfree PWM output measurement)
- Phoenix service software
- Battery voltage 3.7V

Test procedure

Audio can be tested using the Phoenix audio routings option. Three different audio loop paths can be activated:

- External microphone to Internal earpiece
- External microphone to Internal handsfree speaker
- Internal microphone to External earpiece

Each audio loop sets routing from the specified input to the specified output enabling a quick in-out test. Loop path gains are fixed and they cannot be changed using Phoenix. Correct pins and signals for each test are presented in the following table.

Phoenix audio loop tests and test results

The results presented in the table apply when no accessory is connected and battery voltage is set to 3.7V.

Earpiece, internal microphone and speaker are in place during measurement. Applying a headset accessory during measurement causes a significant drop in measured quantities.

The gain values presented in the table apply for a differential output vs. single-ended/differential input.

Loop test	Input terminal	Output terminal	Path gain [dB] (fixed)	Input voltage [mVp-p]	Differe ntial output voltage [mVp- p]	Outp ut DC level [V]	Output current [mA]
External Mic to External Earpiece	XMICP and GND	HSEAR R and GND	-2.9	1000	720	1.2	NA
		HSEAR L and GND					
External Mic to Internal Earpiece	XMICP and GND	EarP and GND	-4.0	750	490	1.2	NA
		EarN and GND					
External Mic to	XMICP and	E2101 pad	8.5	920	2520	0	25mA
Internal handsfree	GND	E2102 pad					(calc.)
Internal Mic to External Earpiece	B2100 (OUT/ GND)	HSEAR R and GND	22.7	100	1360	1.2	NA
		HSEAR L and GND					

Measurement data



Figure 37 Single-ended output waveform of the Ext_in_HP_out measurement when earpiece is connected.





Figure 38 Differential output waveform of the Ext_in_IHF_out out loop measurement when speaker is connected.



Figure 39 Single-ended output waveform of the HP_in_Ext_out loop when microphone is connected.



Earpiece troubleshooting



Internal earpiece troubleshooting





External headset earpiece troubleshooting



IHF troubleshooting

Troubleshooting flow



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IHF troubleshooting



Microphone troubleshooting





Internal microphone troubleshooting



External headset microphone troubleshooting

Troubleshooting flow



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Connections troubleshooting

Bluetooth troubleshooting

Introduction to Bluetooth troubleshooting

There are two main Bluetooth (BT) problems that can occur:

Problem	Description
Detachment of the BT antenna.	This would most likely happen if the device has been dropped repeatedly to the ground. It could cause the BT antenna to become loose or partially detached from the PWB.
A malfunction in the BT ASIC, BB ASICs or the phone's BT SMD components.	This is unpredictable and could have many causes i.e. SW or HW related.

The main issue is to find out if the problem is related to the BT antenna or related to the BT system or the phone's BB and then replace/fix the faulty component. For location of the antenna, please refer to the exploded view in the Parts and layouts section.

Bluetooth settings for Phoenix

Steps

- 1. Start *Phoenix* service software.
- 2. From the **File** menu, choose **Open Product**, and then choose the correct type designator from the **Product** list.
- 3. Place the phone to a flash adapter in the local mode.
- 4. Choose **Testing**→**Bluetooth LOCALS**.
- 5. Locate JBT-9's serial number (12 digits) found in the type label on the back of JBT-9. In addition to JBT-9, also SB-6, JBT-3 and JBT-6 Bluetooth test boxes can be used.
- 6. In the *Bluetooth LOCALS* window, write the 12-digit serial number on the **Counterpart BT Device Address** line.

This needs to be done only once provided that JBT-9 is not changed.

7. Place the JBT-9 box near (within 10 cm) the BT antenna and click **Run BER Test**.

Results

Bit Error Rate test result is displayed in the *Bit Error Rate (BER) Tests* pane in the *Bluetooth LOCALS* window.

Soluetooth LOCALS						
BT Software Operational Mode		I F ^{Se}	If Tests			
			Self Test Name		Result	
Scan Mode			ASIC-Data RAM Flash ASIC-REG access RF-Harmonic alignmer	nt	Unknown Unknown Unknown Unknown	
Bit Error Rate (BER) Tests Counterpart BT Device Address:	00e0031ee61b		,		Ryn	
Bit Frames:	300	_ Ver	sion Information			
Hop Mode:	Europe/USA		Field MCM Software	Value		-
Test Done:	ΟΚ		Locals Software	HCI Ver =	0x3, HCI Re [,]	v
Number of Bits	64800		Checksum Hardware Version	93be 0330		
%Bit Error Rate:	0.03%		Release Date Prod Code	27\10\20 41B141A	04	
Result:	OK		Frod Code Basic Manufacturer HW Release Date	bc4 CSR 01\05\20	D4▶	
	St <u>a</u> rt				<u>R</u> ead	
				<u>C</u> lose	<u><u>H</u>e</u>	lp

Figure 40 BER test result

Bluetooth self tests in Phoenix

Steps

- 1. Start *Phoenix* service software.
- 2. Choose**File**→**Scan Product.**
- 3. Place the phone to a flash adapter.
- 4. From the **Mode** drop-down menu, set mode to **Local**.
- 5. Choose **Testing**→**Self Tests.**
- 6. In the *Self Tests* window check the following Bluetooth related tests:
 - ST_LPRF_IF_TEST
 - ST_LPRF_AUDIO_LINES_TEST
 - ST_BT_WAKEUP_TEST
7. To run the tests, click **Start**.

Test Name	Startup Test	Result	Detailed 4
ST_EAR_DATA_LOOP_TEST	Yes	Passed [0]	
ST_KEYBOARD_STUCK_TEST	No	Not executed [3]	
ST_SIM_CLK_LOOP_TEST	Yes	Passed [0]	
ST_SIM_IO_CTRL_LOOP_TEST	Yes	Passed [0]	
ST_BACKUP_BATT_TEST	Yes	Passed [0]	
ST_LPRF_IF_TEST	No	Not executed [3]	
ST_CAMERA_IF_TEST	No	Not executed [3]	
ST_SIM_LOCK_TEST	Yes	Not executed [3]	
ST_LPRF_AUDIO_LINES_TEST	No	Not executed [3]	
ST_UEM_CBUS_IF_TEST	Yes	Passed [0]	
ST_SLEEPCLK_FREQ_TEST	Yes	Passed [0]	
ST_CMT_APE_WAKEUP_TEST	Yes	Not executed [3]	
ST_MAIN_LCD_IF_TEST	No	Not executed [3]	
ST_BT_WAKEUP_TEST	No	Not executed [3]	
ST_CDSP_TXC_DATA_TEST	No	Not executed [3]	<u> </u>
	Initializa	Details Unsele	

Figure 41 Bluetooth self tests in *Phoenix*

Bluetooth BER failure troubleshooting

Context

Basic encoding rules, BER, is a self-identifying and self-delimiting encoding scheme, which means that each data value can be identified, extracted and decoded individually.





Part 2: Bluetooth self test failed



Bluetooth audio and UI activation troubleshooting

Troubleshooting flow





USB interface troubleshooting

Troubleshooting flow



Baseband manual tuning guide

Certificate restoring for BB5 products

Context

This procedure is performed when the device certificate is corrupted for some reason.

All tunings (RF & Baseband, UI) must be done after performing the certificate restoring procedure. The procedure for certificate restoring is the following:

- Flash the phone with the latest available software using FPS-8 or FPS-10.
- Create a request file.
- Send the file to Nokia by e-mail. Use the following addresses depending on your location:
 - APAC: sydney.service@nokia.com
 - CHINA: repair.ams@nokia.com
 - E&A: salo.repair@nokia.com
 - AMERICAS: fls1.usa@nokia.com
- When you receive a reply from Nokia, carry out certificate restoring.
- Tune the phone completely.
 - **Note:** SX-4 smart card is needed.

• If the phone resets after certificate restoring, reflash the phone again.

Required equipment and setup:

- *Phoenix* service software v 2004.39.7.70 or newer.
- The latest phone model specific *Phoenix* data package.
- PKD-1 dongle
- SX-4 smart card (Enables BB5 testing and tuning features)
- External smart card reader

Note: The smart card reader is only needed when FPS-8 is used. FPS-10 has an integrated smart card reader.

- Activated FPS-8 flash prommer **OR** FPS-10 flash prommer
- Flash update package 03.18.004 or newer for FPS-8 or FPS-10 flash prommers
- CU-4 control unit
- USB cable from PC USB Port to CU-4 control unit
- Phone model specific adapter for CU-4 control unit
- PCS-1 cable to power CU-4 from external power supply
- XCS-4 modular cable between flash prommer and CU-4

Note: CU-4 must be supplied with +12 V from an external power supply in all steps of certificate restoring.

Steps

- 1. Program the phone software.
 - i Start *Phoenix* and login. Make sure the connection has been managed correctly for FPS-8 or FPS-10.
 - ii Update the phone MCU software to the latest available version.If the new flash is empty and the phone cannot communicate with *Phoenix*, reflash the phone.

- iii Choose the product manually from $\textbf{File} {\rightarrow} \textbf{Open Product}$, and click OK.
 - Wait for the phone type designator (e.g. "RM-1") to be displayed in the status bar.
- iv Go to **Flashing**→**SW Update** and wait until *Phoenix* reads the product data as shown in the following picture.

🔓 SW Update				
Product	xx-xx	Co <u>d</u> e		<u> </u>
Image File:			0516982: Scandinavia1 0517773: Euro1	Browse
PPM File:			0518104: France 0518105: Greece	<u>B</u> rowse
Content File:			0518106: RUSSIA 0518107: Hebrew	Browse
Adsp File:			0518108: Arabic 0518117: Ger_Tur 0519119: Alas	Browse
Ape Variant:			0516116. Alps 0518119: Switzerland 0518120: Italu	Browse
Ape Userdisk:			0518121: Scandinavia1	Browse
Flash Type: -		Current	t Status:	
C Restore U	ser Phone			
Phone as	Manufactured	Total P	Process:	
Uutput:				
Reading ph No phone d Reading fla: Product strir Product coo Production : Procedure o	one information letected! sh settings from fi ng is empty. de string is empty. serial number is e completed.	le(s) mpty.		•
	St	art	Abor <u>t</u> Options Close	<u>H</u> elp

Product	is automatically set according to the phone support module which was opened manually, but the flash files cannot be found because the correct data cannot be read from the phone automatically.
Code	must be chosen manually, it determines the correct flash files to be used. Please choose the correct product code (can be seen in the phone type label) from the dropdown list.
Flash Type	must be set to Phone as Manufactured .

v To continue, click **Start**.

Progress bars and messages on the screen show actions during phone programming, please wait.



🖁 SW Update			_ 0 >
Product	RM-1	Code 0516982: Scandinavia1	
Image File:	C:\Program File	s\Nokia\Phoenix\products\RM-1\RM1_2.043915_B4.COR	Erowse
PPM File:	C:\Program File	es\Nokia\Phoenix\products\RM-1\RM1_2.043915.v07	Erowse
Content File:			Erowse
Adsp File:			Erowse
Ape Variant			Erowse
Ape Userdisk:			Erowse
- Flash Type:		Current Status:	
C Restore U	ser Phone	Programming 7%	
Phone as	Manufactured	Total Process:	
		Flashing Procedure 39%	
- <u>0</u> utput:			
Elapsed time Elapsed time Elapsed time Elapsed time Target erasin Next target p Elapsed time	:: 13s :: 24s :: 34s :: 45s ng completed programming :: 63s		_ _
	SI	tart Abor <u>t</u> Options <u>C</u> lose	Help

Programming is completed when *Flashing Completed* message is displayed. The product type designator and MCU SW version are displayed in the status bar.

- vi Close the SW Update window and then choose File \rightarrow Close Product.
- 2. Create a *Request* file.

For this procedure, you must supply +12 V to CU-4 from an external power supply.

- i To connect the phone with *Phoenix*, choose **File** \rightarrow **Scan Product**.
- ii Choose **Tools**→**Certificate Restore**.
- iii To choose a location for the request file, click **Browse**.

🌃 Certificate Restore	
Action © Generate a request file © Process a response file	
Place for request file Filename:	Browse
Place for response file Filename:	Browse
St <u>a</u> rt <u>C</u> lose	<u>H</u> elp

iv Name the file so that you can easily identify it, and click **Open**.

Open						? ×
Look in:	🔄 IMEI		•	🗢 🔁	r 📰 🕈	
History Desktop						
My Computer						
My Network P	File name:	004400281652824			•	Open
	Files of type:	Ask files (*.ask)			-	Cancel
		🗖 Open as read-only				

The name of the file and its location are shown.

🌃 Certificat	e Restore			_ 🗆 X
Action Gener	ate a request file			
	ss a response file			
Filename:	equest file C:\Temp\IMEI\004	400281652824		Browse
Place for re	esponse file			
Filename:				Browse
		St <u>a</u> rt	<u>C</u> lose	<u>H</u> elp

- v To create the *Request* file, click **Start**.
- vi When the file for certificate restore has been created, send it to Nokia as an e-mail attachment.

3. Restore certificate.

For this procedure, you must supply +12 V to CU-4 from an external power supply.

- i Save the reply file sent by Nokia to your computer.
- ii Start *Phoenix* service software.
- iii Choose **File**→**Scan Product**.

iv From the **Tools** menu, choose **Certificate Restore** and select **Process a response file** in the *Action* pane.

Action	Restore		
O <u>G</u> ener	ate a request file		
• Proces	s a response file		
Place for re	auest file		
Filename:	C:\Temp\IMEI\0	04400281652824.ask	 Browse
Disso for re	oponeo filo		
Flace for te	sponse nie		
			Ureuse

- v To choose the location where response file is saved, click **Browse**.
- vi Click **Open**.

Open						<u>? ×</u>
Look in	🔁 IMEI		•	(- 🔁	• 📰 •	
History Desktop My Computer	 ■ 004400281652 ■ 004400281652 	824.ask 824.RPL				
My Network P	File name:	004400281652824.RPL			•	Open
	Files of type:	Rpl files (*.rpl)			•	Cancel
		🔲 Open as read-only				

The name of the file and the path where it is located are shown.

vii To write the file to phone, click **Start**.

🔏 Certificate Restore	
Action © Generate a request file © Process a response file	
Place for request file Filename: C:\Temp\IMEI\004400281652824.ask	Browse
Place for response file Filename: C:\Temp\IMEI\004400281652824.RPL	Browse
St <u>a</u> rt <u>C</u> lose	<u>H</u> elp

Next actions

After a successful rewrite, you must retune the phone completely by using *Phoenix* tuning functions. **Important:** Perform all tunings: RF, BB, and UI.

Energy management calibration

Prerequisites

Energy Management (EM) calibration is performed to calibrate the setting (gain and offset) of AD converters in several channels (that is, **battery voltage**, **BSI**, **battery current**) to get an accurate AD conversion result.

Hardware setup:

- An external power supply is needed.
- Supply 12V DC from an external power supply to CU-4 to power up the phone.
- The phone must be connected to a CU-4 control unit with a product-specific flash adapter.

Steps

- 1. Place the phone to the docking station adapter (CU-4 is connected to the adapter).
- 2. Start *Phoenix* service software.
- 3. Choose **File**→ **Scan Product.**
- 4. Choose **Tuning→Energy Management Calibration.**
- 5. To show the current values in the phone memory, click **Read**, and check that communication between the phone and CU-4 works.
- 6. Check that the **CU-4 used** check box is checked.
- 7. Select the item(s) to be calibrated.

Note: ADC calibration has to be performed before other item(s). However, if all calibrations are selected at the same time, there is no need to perform the ADC calibration first.

8. Click **Calibrate**.

The calibration of the selected item(s) is carried out automatically.

The candidates for the new calibration values are shown in the *Calculated values* column. If the new calibration values seem to be acceptable (please refer to the following "Calibration value limits" table), click **Write** to store the new calibration values to the phone permanent memory.

Parameter	Min.	Max.
ADC Offset	-20	20
ADC Gain	12000	14000
BSI Gain	1100	1300
VBAT Offset	2400	2650
VBAT Gain	19000	23000
VCHAR Gain	N/A	N/A
IBAT (ICal) Gain	7750	12250

Table 10 Calibration value limits

- 9. Click **Read**, and confirm that the new calibration values are stored in the phone memory correctly. If the values are not stored to the phone memory, click **Write** and/or repeat the procedure again.
- 10. To end the procedure, close the *Energy Management Calibration* window.

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Nokia Customer Care

7 — RF Troubleshooting and Manual Tuning Guide

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Introduction to RF troubleshooting

On the following pages you will find a step-by-step troubleshooting procedure and reference measurements at the relevant signal points. For functional descriptions, please refer to the System module section.

Notes on reference measurements

All measurements must be done using:

- spectrum analyser with a high-frequency high-impedance passive probe (LO-/reference frequencies and RF power levels)
- oscilloscope with a 10:1 probe (DC-voltages and low frequency signals)

Important: All measurements with an RF coupler must be performed in an RF shielded environment, or where there are no transmissions on the same frequencies. This may disturb sensitive receiver measurements.

Repairing this phone - important

The RF section of the phone is built around one RF ASIC. Before changing the RF ASIC, please make sure that supply voltages and serial communication coming from baseband to RF are OK.

Please note that the grounding of the FEM module is directly below the FEM module. Therefore, it is difficult to check or change the module.

Most RF semiconductors are static discharge sensitive! ESD protection must be taken care of during repair (ground straps and ESD soldering irons). The RF ASIC and FEM are moisture sensitive, so parts must be prebaked prior to soldering.

In addition to key components, there are lot of discrete components (resistors, inductors and capacitors) which troubleshooting is done mainly by checking if the soldering of the component is done properly.

Capacitor can be checked for shorts and resistors for value by means of an ohmmeter, but be aware in-circuit measurements should be evaluated carefully.

Keep in mind that all measured voltages or RF levels depicted in the service manual are rough figures. Especially RF levels vary because of different measuring equipment or different grounding of the probe used.

When using an RF probe, use a pair of metallic tweezers to connect the probe ground to the PWB ground as close to the measurement point as possible. If measurements are performed in a product specific module jig, then "GND" pads should be used for the probe ground.

Supported bands

The following part of the service manual contains a description of all four GSM bands. It covers both variants, RM-217 and RM-222. Both variants support three GSM bands as follows:

- **RM-217**: GSM900, GSM1800, GSM1900
- **RM-222**: GSM850, GSM1800, GSM1900

Make sure to investigate only the bands, which the phone is made for.



RF key components



Figure 42 RF key components, bottom side main board

Receiver troubleshooting

Introduction to RX troubleshooting

Rx can be tested by making a phone call or in the local mode. For the local mode testing, use Phoenix service software.

The main Rx troubleshooting measurement is RSSI measurement. This test measures the signal strength of the received signal. I and Q branches can be measured separately.

In GSM, the input signal can be either a real GSM signal or a CW signal that is 67.771kHz up from the carrier frequency.

For service tool usage instructions, refer to section Service Tools and Service Concepts.

General instructions for RX troubleshooting

Steps

1. Connect a test jig to a computer with a DAU-9S cable or to a FPS-10 flash prommer with a modular cable (XCS-4).

Make sure that you have a PKD-1 dongle connected to the computer's parallel port.

- 2. Connect CU-4 with 12 V supply. The DC supply voltage is set to 3.7 V by default (in Phoenix).
- 3. Connect an RF cable between the RF connector of the module test jig (MJ-122) and measurement equipment or alternatively use a 50 Ω (at least 2 W) dummy load in the module test jig RF connector, otherwise the RF part may be damaged.

Note: Make sure that all connections are made to the correct RF connector.

- 4. Set Rx on.
 - i Set the phone module to the test jig and start *Phoenix service software*.
 - ii Initialize connection to the phone. (With the FPS-10 prommer use FPS10_USB or FPS10_TCP drivers, depending on connection type. When using DAU-9S select FBUS).
 - iii From the File menu, choose product: **File -> Choose Product -> xx-x*** (* = type designator of the phone, eg. RM-217/222), or press **Ctrl + R** to scan product.
 - iv From the toolbar, set operating mode to "Local".
- 5. EGSM850/900/1800/1900 troubleshooting
 - i From the Testing menu, activate the *RF Controls* window: **Testing -> GSM -> RF Controls**.

Product Flashing	Testing Tuning Tools	Wi	ndow Help
mode: Local	GSM	•	RF Controls
10000	WCDMA	►	RSSI Read
	ADC Reading		SNR Measurement
	Audio Control		
	Autocaller		
	Bluetooth Locals		
	Call Test		

ii In the *RF Controls* window:

- Select band.
- Set Active unit to "Rx" (Default).
- Set Operation mode to "Burst" (Default).
- Set Rx/Tx channel (see table below).
- Apply a frequency (see table below) to the RF-connector.

Note: Remember to compensate for cable attenuation, specific for MJ-122. You will find the values in the Service tools section.

Apply a signal to the RF-connector (remember to compensate for cable attenuation). See values in the table below.

Band	Channel (RX and TX)	Input frequency (MHz)	Offset (kHz)	Power level (dBm)
GSM850	190	881.66771	67.710	-90
GSM900	37	942.46771	67.710	-90
GSM1800	700	1842.86771	67.710	-90
GSM1900	661	1960.06771	67.710	-90

🔀 RF Controls				
Common GSM RF	Control Values-		ررىكى	
Acti <u>v</u> e Unit:	Rx 💌	R <u>x</u> /Tx Channel:	37	942.400000
<u>B</u> and:	GSM 900 💌	<u>A</u> FC:	0	
Operation Mode:	Burst 💌			
RX Control Values				
Monitor Cha <u>n</u> nel:	37 942.400	0000		
A <u>G</u> C:	22			_
TX Control Values				
E <u>dg</u> e:	Off	Tx Data Type:	All 1	7
Tx PA <u>M</u> ode:	High 💌	Tx Po <u>w</u> er Level:	5	7
			<u>C</u> lose	<u>H</u> elp

Figure 43 RF Controls window

Receiver (RX) troubleshooting

Context

Troubleshoot one band at a time. Start with GSM850 (RM-222) or GSM900 (RM-217), and end with GSM1900.

Receiver troubleshooting

Apply a signal according to the table in General instructions for RX troubleshooting (page 7–7)



GSM850 or GSM900







GSM Rx chain activation for manual measurements / GSM RSSI measurement

Context

RSSI signal measurement is the main Rx troubleshooting measurement. The test measures the strength of the received signal.

I and Q branches can be measured separately. In GSM, the input signal can be either a real GSM signal or a CW (Continuous Wave) signal that is 67.771 kHz above the carrier frequency.

Steps

- 1. Start *Phoenix* service software.
- 2. Choose **Testing** \rightarrow **GSM** \rightarrow **RSSI Reading**.
- 3. Set the RF signal generator for a channel frequency +67.771 kHz in CW mode with a –80 dBm signal level. Alternatively set the cellular tester downlink channel to the appropriate channel. Make sure that the tester is set to continuous mode, not to burst mode.
- 4. In the *RSSI Reading* window, select the appropriate band and channel.



Figure 44 RSSI Reading window

5. To start the measurement, activate GSM Rx chain, click **Start**.

Results

RSSI reading values of the selected band and channel are displayed. The RSSI level must be the same value as that which is set at the signal generator (-80 dBm).

Transmitter troubleshooting

General instructions for TX troubleshooting

Context

- Tx troubleshooting requires Tx operation.
- Do not transmit on frequencies that are in use!
- Transmitter can be controlled in the local mode for diagnostic purposes.
- The most useful Phoenix tool for GSM transmitter testing is "RF Controls".

- Tx IQ tuning and Tx power tuning can be also used in some cases.
- Remember that retuning is not a fix! Phones are tuned correctly in production.

The first set of steps instructs how to assemble the test setup. This setup is general for all Tx troubleshooting tasks.

Alternative steps provide specific troubleshooting instructions for *Phoenix* service software.

Caution: Never activate the GSM transmitter without a proper antenna load. There should be always 50 Ω load connected to the RF connector (antenna, RF-measurement equipment or at least 2 W dummy load), otherwise the GSM Power amplifier may be damaged.

Steps

1. Connect a test jig to a computer with a DAU-9S cable or to a FPS-10 flash prommer with a modular cable (XCS-4).

Make sure that you have a PKD-1 dongle connected to the computer's parallel port.

- 2. Connect CU-4 with 12 V supply. The DC supply voltage is set to 3.7 V by default (in Phoenix).
- 3. Connect an RF cable between the RF connector of the module test jig (MJ-122) and measurement equipment or alternatively use a 50 Ω (at least 2 W) dummy load in the module test jig RF connector, otherwise GSM may be damaged.

Note: There are two antenna connectors in the module jig:

- one for GSM
- one for Bluetooth

Make sure that all connections are made to the correct RF connector.

Normally a spectrum analyser is used as measurement equipment.

Note: The maximum input power of a spectrum analyser is +30 dBm.

To prevent any damage, it is recommended to use 10 dB attenuator on the spectrum analyzer input.

- 4. Set Tx on.
 - i Set the phone module to the test jig and start *Phoenix service software*.
 - ii Initialize connection to the phone. (With the FPS-10 prommer use FPS10_USB or FPS10_TCP drivers, depending on connection type. When using DAU-9S select FBUS driver).
 - iii From the File menu, choose product: **File -> Choose Product -> xx-x*** (* = type designator of the phone, e.g. RM-217/222), or press**Ctrl + R** to scan product.
 - iv From the toolbar, set operating mode to "Local".
- 5. GSM850/900/1800/1900 troubleshooting
 - i From the Testing menu, activate the *RF Controls* window: **Testing -> GSM -> RF Controls**.



- ii In the *RF Controls* window:
 - Select band "GSM850", "GSM900" or "GSM1800" or "GSM1900".
 - Set Active unit to "Tx" (Default = "Rx").

- Set Operation mode to "Burst" (Default).
- Set Tx data type to "All1" (Default).
- Set Rx/Tx channel (see table below)
- Set Edge to "Off" (Default).
- Set Tx PA mode to "High" (Default).
- Set power level (see table below)

Band	Channel (RX and TX)	TX power level
GSM850	190	5
GSM900	37	5
GSM1800	700	0
GSM1900	661	0

🌃 RF Controls				_ 🗆 🗙
Common GSM RF	Control Values			
Acti <u>v</u> e Unit:	Tx	R <u>x</u> /Tx Channel:	37 8	97.400000
<u>B</u> and:	GSM 900 💌	AFC:	0	
Operation Mode:	Burst 💌			
RX Control Values				
Monitor Cha <u>n</u> nel:	37 942,40000	0		
A <u>G</u> C:	22			~
TX Control Values				
E <u>dg</u> e:	Off 💌	Tx Data Type:	All 1	-
Tx PA <u>M</u> ode:	High 💌	Tx Po <u>w</u> er Level:	5	•
		<u>!</u>		Help

Figure 45 RF Controls window

Transceiver (TX) troubleshooting

Troubleshooting flow





Checking antenna functionality

GSM antenna

In the GSM antenna, there is one feed and two GND contacts.

Between GND1 and Feed, a DC short-circuit can be measured.

GND2 has no DC connection to the other contacts.

The antenna is functioning normally, if the contact pads hit the antenna C-clips on the PWB and the antenna is visually intact.

BT antenna

The BT antenna is (as the GSM antenna) placed on the flex foil on the antenna module. It has one feed and one short contact. The antenna is functioning normally, if the contact pads hit the antenna C-clips on the PWB and the antenna is visually intact.



Figure 46 Location of the GSM and BT antenna C-clips on the PWB





Figure 47 GSM and BT antenna contact pads on the antenna module

Antenna C-clips

When checking the antenna functionality, you can also check that the antenna C-clips are intact (that is, there are no cracks/bends in them).



Figure 48 Antenna C-clips on the PWB

Synthesizer troubleshooting

Synthesizer troubleshooting



RF tunings

Introduction to RF tunings

Important: Only perform RF tunings if:

- one or more of the RF components have been replaced
- flash memory chip is replaced or corrupted.

RF calibration is always performed with the help of a product-specific module jig (MJ-122), never with an RF coupler. Using an RF coupler in the calibration phase will cause a complete mistuning of the RF part.

Important: After RF component replacements, **always** use autotuning. Manual tunings are only required in rare cases.

Cable and adapter losses

RF cables and adapters have some losses. They have to be taken into account when the phone is tuned. As all RF losses are frequency dependent, the user has to act very carefully and understand the measurement setup.

For RF attenuations of the module jig, please refer to the Service tools section.

Auto tuning for BB5.0

This phone can be tuned automatically.

Autotune is designed to align the phone's RF part easier and faster. It performs calibrations, tunings and measurements of RX and TX. The results are displayed and logged in a result file, if initiated.

Hardware set up

Hardware requirements for auto tuning:

- PC (Windows 2000/XP) with GPIB card
- Power supply
- Product specific module jig
- Cables: XRF-1 (RF cable), USB cable, GBIP cable and DAU-9S
- Signal analyser (TX), signal generator (RX) and RF-splitter *or* one device including all.



Figure 49 Auto tuning concept with CMU200

Phoenix preparations

Install the phone specific data package, for example *RM-217/222_dp_1.78_sw_sh3.26.exe*. This defines phone specific settings..

Auto tuning procedure

- 1 Make sure the phone (in the jig) is connected to the equipment. Else, some menus will not be shown in Phoenix.
- 2 To go to autotune, select *Tuning (Alt-U) > Auto-Tune (Alt-A)* from the menu.
- 3 Start autotuning, clicking the *Tune* button.

System mode independent manual tunings

RF channel filter calibration

Context

Rf channel filter calibration tunes the internal low pass filters of the RF ASIC, that limit the bandwidth of BB IQ signals.

	Min	Тур	Max
Tx filter	0	10	31
RX mixer	0	13	31
Rx filter	0	16	31

Table 11 Rf channel filter calibration tuning limits

Steps

- 1. From the **Operating mode** drop-down menu, set mode to **Local**.
- 2. Choose **Tuning** \rightarrow **Rf Channel Filter Calibration**.
- 3. Click Tune.
- 4. To save the values to the PMM (Phone Permanent Memory) area, click **Write**.
- 5. To close the *Rf Channel Filter Calibration* window, click **Close**.

Results

¥,	Rf Channel	Filter Calibration	and the		_ 🗆 🗡
	Cut-off Free	quencies			
	Tx filter:	II			
	Rx mixer:	16	Rx filter:	16	
	<u>I</u> une	<u>B</u> ead	<u>W</u> rite		Help

Figure 50 Rf channel filter calibration typical values

PA (power amplifier) detection

Context

The PA detection procedure detects which PA manufacturer is used for phone PAs.

If a PA is changed or if the permanent memory (PMM) data is corrupted, PA detection has to be performed before Tx tunings.

Steps

- 1. From the **Operating mode** drop-down menu, set mode to **Local**.
- 2. Choose **Tuning** \rightarrow **PA Detection**.
- 3. Click **Tune**.
- 4. Check that the detected PA manufacturers are corresponding to the actual chips on the board.
- 5. To end the procedure, click **Close**.

GSM receiver tunings

Rx calibration (GSM)

Context

Rx Calibration is used to find out the real gain values of the GSM Rx AGC system and tuning response of the AFC system (AFC D/A init value and AFC slope)

Steps

- 1. Connect the GSM connector of the module jig to a signal generator.
- 2. Start *Phoenix* service software.
- 3. From the **Operating mode** drop-down menu, set mode to **Local**.
- 4. Choose **Tuning** \rightarrow **GSM** \rightarrow **Rx Calibration**.

5. Click **Start**.

🌃 Phoenix	
File Edit Product Flashing Testing Tuning Tools Window Help	
Operating mode: Local	
Rx Calibration	
PM values:	
Nevt	
Start Abort Close Help	

6. Connect the signal generator to the phone, and set frequency and amplitude as instructed in the **Rx Calibration with band EGSM900** (step 1-3) pop-up window.

Important: The calibration uses a non-modulated CW signal. Increase the signal generator level by cable attenuation and module jig probe attenuation.

🔞 Phoenix	<u>_ ×</u>
File Edit Product Flashing Testing Tuning Tools Window H	felp
Operating mode: Local	
🔞 Rx Calibration	
PM values:	
Afc val Afc slop Afc slop	1900 🔀
Rssi Set the Rf signal generator:	
Power level: -60 dBm	
Input signal frequency: 942.467710 MHz	
Press OK to tune, press Cancel or ESC to exit tuning pr	ocess.
OK Cancel	
<u>N</u> ext	
Start Abort <u>C</u> lose <u>H</u> elp	

- 7. To perform the tuning, click **OK**.
- 8. Check that the tuning values are within the limits specified in the following table:

Table 12 RF tuning limits in Rx calibration

	Min	Тур	Мах	Unit			
GSM850	GSM850						
AFC Value (init)	-200	-8040	200	-			
AFC slope	0	108121	200	-			
RSSI (AGC-0)	106	107110	114	dB			
GSM900			-				
AFC Value (init)	-200	-10562	200	-			
AFC slope	0	122	200	-			
RSSI (AGC-0)	106	107110	114	dB			
GSM1800	GSM1800						
RSSI (AGC-0)	105	105109	114	dB			
GSM1900							
RSSI (AGC-0)	105	105109	114	dB			

9. Click **Next** to continue with GSM1800 Rx tuning.

🌃 Rx Calibra	ation					<u>- </u>
Calibration	values: -					
Afc value Afc slope Rssi	:	-46.0000 127.0000 107.0000	00 100 100			<u></u>
						T
					<u>N</u> e	**
St <u>a</u> rt		A <u>b</u> ort		<u>C</u> lose		<u>H</u> elp

Next actions

Repeat steps 6 to 9 for GSM1800 and GSM1900

Rx band filter response compensation (GSM)

Prerequisites

Rx calibration must be performed before the Rx band filter response compensation.

Context

On each GSM Rx band, there is a band filter in front of the RF ASIC front end. The amplitude ripple caused by these filters causes ripple to the RSSI measurement, and therefore calibration is needed. The calibration has to be repeated for each GSM band.

Steps

- 1. Connect the GSM connector of the module jig to a signal generator.
- 2. Start *Phoenix* service software.
- 3. From the **Operating mode** drop-down menu, set mode to **Local**.

- 4. Select **GSM850** or **GSM900** band.
- 5. Choose **Tuning**→**GSM**→**Rx Band Filter Response Compensation**.
- 6. Select **Tuning mode: manual**
- 7. Click **Start**.

K Phoenix						
File Edit Product Flashing Testing Tuning Tools Window Help						
Operating mode: Local						
K Rx Band Filter Response Compensation						
Tuning Mode: Manual 💌 Input Signal Level -60 💼						
Channel Input Frequency [MHz] Measured Level Difference [dB]						
Next						
Start Abort Close Help						
	1					

8. Connect the signal generator to the phone, and set frequency and amplitude as instructed in the *Rx Band Filter Response Compensation for EGSM850/EGSM900* pop-up window, step 1-3.

Tuning step 1 of 3 - Rx Band Filter Response Compensation for EGSM900					
Manual Tuning - stage 1 of 9.					
Set the Rf signal generator:					
Power level: -60 dBm + cable attenuation					
Input signal frequency: 923.26771 MHz					
Press OK to tune, press Cancel or ESC to exit tuning process.					
OK Cancel					
- 9. To perform tuning, click **OK**.
- 10. Go through all 9 frequencies. The following table will be shown:

Rx Band Filt	er Response Compensati	on 📃
Tuning <u>M</u> ode:	Manual 💌 Inp	ut Signal Level -60
Signal levels		
Channel	Input Frequency [MHz]	Measured Level Difference [dB]
965	923.26771	-0.328
975	925.26771	-0.109
987	927.66771	0.422
1009	932.06771	0.422
37	942.46771	0.000
90	953.06771	-0.828
114	957.86771	-0.969
124	959.86771	-0.578
136	962.26771	-0.828
		(New Y
	Start	Abort Close Help

11. Check that the tuning values are within the limits specified in the following table:

	Min	Тур	Мах	Unit
GSM850				
Ch. 118/867.26771 MHz	-6	-1	2	dB
Ch. 128/869.26771 MHz	-3	0	2	dB
Ch. 140/871.66771 MHz	-3	0	2	dB
Ch. 172/878.06771 MHz	-2	0	2	dB
Ch. 190/881.66771 MHz	-2	0	2	dB
Ch. 217 / 887.06771 MHz	-2	0	2	dB
Ch. 241/891.86771 MHz	-3	0	2	dB
Ch. 251/893.86771 MHz	-3	0	2	dB
Ch. 261/895.86771 MHz	-6	-1	-2	dB
GSM900	-	-	-	
Ch. 965 / 923.26771 MHz	-6	-1	2	dB
Ch. 975 / 925.26771 MHz	-3	0	2	dB
Ch. 987 / 927.66771 MHz	-3	0	2	dB
Ch. 1009 / 932.06771 MHz	-2	0	2	dB

	Min	Тур	Max	Unit
Ch. 37 / 942.46771 MHz	-2	0	2	dB
Ch. 90 / 953.06771 MHz	-2	0	2	dB
Ch. 114 / 957.86771 MHz	-3	0	2	dB
Ch. 124 / 959.86771 MHz	-3	0	2	dB
Ch. 136 / 962.26771 MHz	-6	-1	2	dB
GSM1800				
Ch. 497 / 1802.26771 MHz	-6	-1	3	dB
Ch. 512 / 1805.26771 MHz	-3	0	3	dB
Ch. 535 / 1809.86771 MHz	-3	0	3	dB
Ch. 606 / 1824.06771 MHz	-3	0	3	dB
Ch. 700 / 1842.86771 MHz	-3	0	3	dB
Ch. 791 / 1861.06771 MHz	-3	0	3	dB
Ch. 870 / 1876.86771 MHz	-3	0	3	dB
Ch. 885 / 1879.86771 MHz	-3	0	3	dB
Ch. 908 / 1884.46771 MHz	-6	-1	3	dB
GSM1900				·
Ch. 496 / 1927.06771 MHz	-6	-1	2	dB
Ch. 512 / 1930.26771 MHz	-3	0	2	dB
Ch. 537 / 1935.26771 MHz	-3	0	2	dB
Ch. 586 / 1945.06771 MHz	-3	0	2	dB
Ch. 661 / 1960.06771 MHz	-3	0	2	dB
Ch. 736 / 1975.06771 MHz	-3	0	2	dB
Ch. 794 / 1986.66771 MHz	-3	0	2	dB
Ch. 810 / 1989.86771 MHz	-3	0	2	dB
Ch. 835 / 1994.86771 MHz	-6	-1	2	dB

12. If the values are within the limits, click **Next** to continue to the next band.

Next actions

Repeat the steps 8 to 12 for GSM1800 and GSM1900.

GSM transmitter tunings

Tx IQ tuning (GSM)

Context

The Tx path branches to I and Q signals at RF I/Q modulator. Modulator and analog hardware located after it cause unequal amplitude and phase disturbance to I and Q signal paths. Tx IQ tuning balances the I and Q branches.

Tx IQ tuning must be performed for all GSM bands.

Steps

- 1. Start *Phoenix* service software.
- 2. From the **Operating mode** drop-down menu, set mode to **Local**.
- 3. Choose Tuning \rightarrow GSM \rightarrow Tx IQ Tuning.
- 4. Select Mode: Automatic.

Ķ	Tx	IQ Selftuning				_ 🗆 >
Settings Cha <u>n</u> nel: 190 P <u>o</u> wer Level: 10 💌						
	- Tur	ning Values				
		Band	Dc Offset I	Dc Offset Q	Amplitude	Phase
		GSM850/Edge	-0.144	-0.576	-0.1	89.00
		GSM900/Edge	-0.144	-0.592	-0.1	89.00
		GSM1800/Ed	0.792	-0.180	0.1	94.00
		GSM1900/Ed	0.900	-0.160	0.1	93.00
					Iune	<u>R</u> ead
			St <u>a</u> rt	<u>F</u> inish	<u>C</u> lose	Help

- 5. Select band **GSM850** or **GSM900** and click **Start**.
- 6. Click **Next** to start GSM1800 band TX IQ tuning.
- 7. Click **Next** to start GSM1900 band TX IQ tuning.
- 8. Click**Finish** and then **Close**.

Next actions

Tuning sliders should be close to the center of the scale after the tuning and within the limits specified in the following table. If they are not within the limits, check Tx IQ quality manually.

	Min	Тур	Мах	Unit
GSM850				
I DC offset / Q DC offset	-6	-4	6	%
Ampl	-1	0	1	dB
Phase	85	90	95	o
GSM900				

	Min	Тур	Мах	Unit
I DC offset / Q DC offset	-6	-4	6	%
Ampl	-1	0	1	dB
Phase	85	90	95	o
GSM1800/GSM1900)		-	
I/Q DC	-6	0.5	6	%
Ampl	-1	0	1	dB
Phase	95	100	110	o

Tx power level tuning (GSM)

Context

Because of variations at the IC (Integrated Circuit) process and discrete component values, the actual transmitter RF gain of each phone is different. Tx power level tuning is used to find out mapping factors called 'power coefficients'. These adjust the GSM transmitter output power to fulfill the specifications.

For EDGE transmission, the bias settings of the GSM PA are adjusted in order to improve linearity. This affects the PA gain and hence the power levels have to be aligned separately for EDGE transmission.

Tx power level tuning has to be performed on all GSM bands.

Steps

- 1. Connect the phone to a spectrum analyzer.
- 2. Start *Phoenix* service software.
- 3. From the **Operating mode** drop-down menu, set mode to **Local**.
- 4. Choose Tuning \rightarrow GSM \rightarrow Tx Power Level Tuning.

5. Click **Start**.l

Tx Power Level T	uning		
Settings <u>B</u> and GSM850	Ŧ	Freq. [MHz]	836.60
Power Levels			
Power Level	Value	Target	DAC 🔺
14 Coeff.	0.2830	15.0	290
15 Coeff.	0.2656	13.0	272
16 Coeff.	0.2516	11.0	258
17 Coeff.	0.2386	9.0	244
18 Coeff.	0.2280	7.0	233
19 Coeff.	0.2166	5.0	222
Base Coeff.	0.0869		89
2SlotThreshold	7.0000		7168
2SlotCoefficient	0.5596	30.5	573
3SlotThreshold	7.0000		7168
3SlotCoefficient	0.5596	30.5	573
4SlotThreshold	7.0000		7168
4SlotCoefficient	0.5596	30.5	573 💌
•			•
		<u>R</u> ead	<u>N</u> ext
Start	<u>F</u> inish	<u>C</u> lose	<u>H</u> elp

6. Set the spectrum analyzer for power level tuning:

Frequency	Channel frequency:
	• 836.6 MHz GSM850
	• 897.4MHz GSM900
	• 1747.8MHz GSM1800
	• 1880MHz GSM1900
Span	0 Hz
Sweep time	2ms
Trigger	Video triggering (-10dBm)

Resolution BW	3MHz
Video BW	3MHz
Reference level offset	sum cable attenuation with module jig attenuation
Reference level	33dBm

A power meter with a peak power detector can be also used. Remember to take the attenuations into account.

- 7. Adjust power for all bold power levels to correspond the **Target dBm** column by pressing **+** or **–** keys.
- 8. If all bold power levels are adjusted, click **Next** to continue with **GSM850 EDGE**.
- 9. Adjust power for all bold power levels to correspond the **Target dBm** column by pressing **+** or **–** keys.

Next actions

Continue tuning the bold power levels of the GSM900, GSM1800 and GSM1900 bands. You will see this message, if finished successfully:



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8 — System module



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Phone description

Introduction

This chapter describes the system module including engine, power management, interfaces, audio etc.

The baseband is based on BB5.0 with a RAPGSM main processor and Retu/Tahvo energy management. All blocks that require high voltage process are in Tahvo and all other in Retu. The RF part is based on the ASIC Ahne.

RM-217/222 is a monoblock phone, in which all electrical components are assembled into one PWB.

RM-217 operates on the GSM 900/1800/1900 bands.

RM-222 operates on the GSM 850/1800/1900 bands.

Key components

Function	Name	Item
Energy management	Retu	D2200
	Tahvo	N2300
Main processor	RAPGSM	D2800
Memory	Combo: 128 Mbit SDRAM & 256 Mbit NOR flash	D3000
RF ASIC	Ahne	N7505
Front end module	Power amplifier and Antenna Switch	N7520
Antenna	Antenna module assembly	
	• RM-217: 900/1800/1900 MHz	
	• RM-222: 850/1800/1900 MHz	
System connector	AV connector	X2030
	mini USB connector	X2002
Battery	BL-4C, 3.7 V, 860 mAh	
Bluetooth	BC4-ROM	N6030
FM radio	TEA5760	N6100
IHF Speaker	Donau or Aura (in antenna module assembly)	
Earpiece	RDF-07A 320HM 10.86x7.40.2.2	B2101
Microphone	Clapton	B2100
Vibra	SMD VIBRA MOTOR	M2100
Charger connector	2 mm Nokia charger interface	X2000
Camera	2.0 Mpix SMIA85	
HWA	STV0984N	D3300
Display	QVGA 240 x 320, 2"	
LED driver	TPS 61061 YZFR	N2301
RTC battery	311 size	G2200

PWB overview

PWB placement - Top



System block diagram



Board and module connections



Figure 52 Board and module connections

Engine

Engine modules

The engine contains

- RF module with Ahne ASIC
- Main processor with integrated memory (Baseband)
- Energy management Retu and Tahvo (Baseband)



• SDRAM and NOR flash memories

RF engine

The RF module performs the high frequency operations of the engine for GSM. In both transmitter and receiver, the modulator and demodulator operate at the channel frequency.

The core components of the RF module are:

- Ahne RF ASIC (application specific integrated circuit)
- Front end module (FEM) module (Power amplifier and Antenna switch)

The RF engine also includes:

- Voltage controlled oscillators (VCO and VCTCXO)
- SAW filters

The baseband section controls the RF module through the serial bus, RFBus. This passes information about eg. frequency band and mode of operation. Ahne RF ASIC controls the mode of operation, and further sends control signals to the front end module.

In addition to the RFBus there are other interface signals for the power control loop, VCTCXO control and for the modulated waveforms.

Main processor

The main processor in this device is RAPGSM, a BB5.0 ASIC.

Some of its interfaces, processors and controllers are:

- General purpose UARTs
- Processor modules
- I2C (between ICs) interface
- GSM coder
- Interfaces to user interface, SIM and MMC
- Accessory interface
- Handling of RF-BB interface
- I/O voltage = 1.8 V, Core voltage <1.8 V

Energy management

Two ASICs manages the energy in the phone; Retu and Tahvo. Together they cover the analogue audio and energy management function needs.

Tahvo

All blocks that need a special silicon process are included in Tahvo.

Tahvos main features are:

- Energy management control
- Supply voltage generation
- Charge control
- Digital core supply
- Current control for LED supply

Retu

The blocks that do not have special needs are included in Retu. Retu controls for example:

- Audio block
- SIM
- FM radio

Modes of operation

The functional behavior can be divided into seven different states. Each of these states will affect the general functionality of the phone:

- No supply
- Backup
- Power off
- Reset
- Power on
- Deep sleep

Battery and charging

Battery

- Type: BL-4C, Li-Ion
- Capacity: 860 mAh
- BSI resistor nominal value: 75 $k\Omega$

Battery temperature is measured on the NTC on the main board.



Battery connector

The battery connector has three poles:

- BSI (Battery size indicator)
- GND (Ground)
- VBAT (Battery voltage)

The BSI line is used to recognize the battery capacity by a battery internal pull down resistor.

Charging

This phone is charged through the smaller Nokia standard interface (2.0 mm plug). The old standard charger (3.5 mm) can be used together with the CA-44 charger adapter.



Charging is controlled by energy management, and external components are needed to protect the baseband module against EMC, reverse polarity and transient frequency deviation.

Interfaces

FM radio

This phone uses a single-chip electronically tuned FM stereo radio with low voltage application.



Figure 54 FM radio interface

Camera

Camera interface

The RM-217/222 has a **2.0 Megapixel** camera, supported by a hardware accelerator.



SIM

The SIM interface is the electrical interface between the SIM card and the mobile phone engine. The data communication between the SIM card and the phone is asynchronous half duplex.



Figure 55 SIM interface connections

SIM Logic level shifting

The SIM interface can support 3V and 1.8V SIM cards.

SIM Power up/down

The SIM power up/down sequence is generated in Retu. This means that Retu generates the reset switch (RST) signal to the SIM. In addition, the SIMCardDet signal is connected to Retu.

The SIM interface is powered up when the SIMCardDet signal indicates "card in".

µSD card interface



The µSD card is connected to the engine by an external level shifter and ESD protection filter. Supplied voltages:

- VMMC: 2.85 V (from level shifter)
- VIO: 1.8 V (from Retu)

The card removal is detected by a push detect switch.

User interface

Display

The display unit comprises a parallel interface.

Keyboard

All keys are placed on the main PWB.

- Numeric keys
- Navigation key, Soft keys, Start, and End
- Power switch
- Volume up and down switch

Display and keypad backlight

There are two sets of LEDs illuminating the display and the keypads:

- Display LEDs, 4pcs
- Main keypad on PWB, 4 pcs, white colour

All sets share the same driver. None of the keypads can be illuminated without the LCD backlight being turned on.

Reminder lights

Two additional blue LEDs serve as reminder lights for missed calls/text messages.

Audio concept

Audio concept

The functional core of the audio hardware is built around two ASICs; RAP engine and Retu. Retu provides an interface for the trancducers and the AV connector. There are three audio transducers:

- 1 dynamic earpiece
- 1 dynamic speaker
- 1 microphone module

Retu also provides an output for the vibra motor.

All external audio accessories are connected to the specific audio connector.



Figure 56 Audio block diagram

Internal audio

The internal audio components are used in these modes:

	Hand portable (HP) mode	Internal hands free (IHF) mode
Microphone	x	x
Earpiece	X	
Speaker		X

Connections

AV connector

Headsets and other galvanic accessories are connected to the specific audio input. The accessory mode is automatically enabled/disabled when a dedicated accessory is connected/disconnected.

Note: When testing external audio through the audio connector, make sure that the specific accessory can be used with this phone!

USB

USB (Universal Serial Bus) provides a wired connectivity between a PC and peripheral devices. It is a differential serial bus.

USB 2.0 is supported with full speed (12 Mbps).

Hot swap is supported, which means that USB devices may be plugged in/out at any time.

This phone is provided with a specific connector for mini USB.



Bluetooth

Bluetooth provides a fully digital link for communication between a master unit and one or more slave units. This bluetooth solution is a single chip solution.

Bluetooth connects to RAPGSM on the GENIO and GPIO busses.

The Bluetooth module is provided with power from VBat.



Figure 57 Bluetooth interface block diagram

Technical specifications

General specifications

Unit	Dimension (mm)	Weight (g)	Volume (cc)
Transceiver with BL-4C 860 mAh Li-Ion battery pack	106,8 x 43,8 x 13,1	91	55,6

Battery endurance

Battery	Talk time	Standby time	Music time
BL-4C 860 mAh Li-ion	3 - 3.5 hours	Up to 300 hours	> 10 hours

Note: Variation in operation times will occur depending on SIM card, network settings and usage. Talk time is increased by up to 30% if half rate is active, and reduced by 5% if enhanced full rate is active.

Environmental conditions

Temperature

Temperature range	Min °C	Max °C
Operational (all specs met)	-5	+55
Functional (reduced performance)	-30	+70
Storage	-30	+85

The HW module complies with the SPR4 Operating Conditions.

Humidity

Relative humidity range is 5...95%.

The hardware module is not protected against water. Condensed or splashed water might cause malfunction. Any submerge of the phone will cause permanent damage. Long-term high humidity, with condensation, will cause permanent damage because of corrosion.

The hardware module complies with the SPR4 Operating Conditions.

Electrical characteristics

Table 13 Normal and extreme voltages

Voltage	Voltage (V)	Condition
General conditions		
Nominal voltage	3.7	
Lower extreme voltage	3.06	a

Voltage	Voltage (V)	Condition
Higher extreme voltage	4.2	b

a. ADC settings in the SW might shutdown the phone above this value.

b. During fast charging of an empty battery, this voltage might exceed this value. Voltages between 4.20 and 4.60 might appear for a short while.

Main RF characteristics

System	Channel number	TX frequency	RX frequency	Unit
GSM850	128 <= n <= 251	F = 824.2 + 0.2*(n - 128)	F = 869.2 + 0.2* (n-128)	MHz
GSM900	0 < =n <= 124	F = 890 + 0.2*n	F = 935 + 0.2*n	MHz
	975 <= n <= 1023	F = 890 + 0.2* (n - 1024)	F = 935 + 0.2*(n -1024)	MHz
GSM1800	512 <= n <= 885	F = 1710.2 + 0.2* (n - 512)	F = 1805.2 + 0.2* (n-512)	MHz
GSM1900	512 <= n <= 810	F = 1850.2 + 0.2* (n - 512)	F = 1930.2 + 0.2* (n-512)	MHz

Table 14 Channel numbers and frequencies

Table 15 Main RF characteristics

Parameter	Unit and value
Cellular systems	RM-217 : EGSM900/GSM1800/GSM1900
	RM-222 : GSM850/GSM1800/GSM1900
RX Frequency range	GSM850: 869 894 MHz
	EGSM900: 925 960 MHz
	GSM1800: 18051880 MHz
	GSM1900: 19301990 MHz
TX Frequency range	GSM850: 824 849 MHz
	EGSM900: 880 915 MHz
	GSM1800: 17101785 MHz
	GSM1900: 18501910 MHz
Duplex spacing	GSM850: 45 MHz
	EGSM900: 45 MHz
	GSM1800: 95 MHz
	GSM1900: 80 MHz
Channel spacing	200 kHz

Parameter	Unit and value
Number of RF channels	GSM850: 124
	EGSM900: 174
	GSM1800: 374
	GSM1900: 300
Output Power	GSM850: GSMK 533 dBm
	GSM850: 8-PSK 526.5 dBm
	EGSM900: GSMK 533 dBm
	EGSM900: 8-PSK 526.5 dBm
	GSM1800: GSMK 030 dBm
	GSM1800: 8-PSK 025.5 dBm
	GSM1900: GSMK 030 dBm
	GSM1900: 8-PSK 025.5 dBm
Number of power levels GMSK	GSM850: 15
	EGSM900: 15
	GSM1800: 16
	GSM1900: 16
Number of power levels 8-PSK	GSM850: 12
	EGSM900: 12
	GSM1800: 14
	GSM1900: 14

Table 16 Transmitter characteristics

Item	Values
Туре	Direct conversion, nonlinear, FDMA/TDMA
LO frequency range	GSM850: 32963576 MHz (4 x TX freq)
	EGSM900: 35203660 MHz (4 x TX freq)
	GSM1800: 34203570 MHz (2 x TX freq)
	GSM1900: 37003820 MHz (2 x TX freq)
Output power	GMSK 33/33/30/30 dBm
(GSM850/EGSM900/GSM1800/	8-PSK 26.5/26.5/25.5/25.5 dBm
GSM1900)	
Gain control range	min. 30 dB
Phase error (RMS/peak), GMSK	5 deg./20 deg. peak
EVM (RMS/peak), 8-PSK	10%/30%

Table 17 Receiver characteristics

Item	Values
Туре	Direct conversion, Linear, FDMA/TDMA
LO frequencies	GSM850: 34763576 MHz (4 x RX freq)
	EGSM900: 37003840 MHz (4 x RX freq)
	GSM1800: 36103760 MHz (2 x RX freq)
	GSM1900: 38603980 MHz (2 x RX freq)
Typical 3 dB bandwidth	+/- 91 kHz
Sensitivity	min 102 dBm (normal condition)
Total typical receiver voltage gain (from antenna to RX ADC)	86 dB
Receiver output level (RF level -95 dBm)	40 mVpp, single-ended I/Q signals to RX ADCs



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9 — Schematics



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AV connector, mini USB, charger jack





RETU, SIM, Audio





TAHVO





RAPGSM, Combo, microSD







FM radio, Bluetooth







User interface





Camera




RF part







Signal overview

1) 32kHz at C2208 in	2) 32 kHz at C2209 out	3) SerClk at J2206	4) SerData at J2207
chlido - 3.32mV, mo - 140mV phple 435mV, free 32.7kts	childe - 1.40mV, me - 220mV phpk- 650mV, freq- 32.002z	chlide - 595mV, me - 1.02 V phyle 2.34 V, free 55.792tz	chlide - 352eV, me - 631eV phpie 1.34 V, free-62.582s
		CE 5000+ FE 1004 cit-	
5) SerSelX at J2209	6) SIMClk1 at J2213	7) SIMDa1 at J2214	8) SIMIOC1 at J2215
chlido = 907mV, ms = 1.30 V pkpk= 1.54 V, frec= 50.00Hz	chl:dc = 913aV, ms = 1.30 V pkpk= 2.08 V, freq= 3.84MHz	chl:do = 1.42 V, zms = 1.62 V pkpk= 1.94 V, freq= 2.085Mz	chlido = 90%W, cmd = 1.29 V pápk= 1.92 V, freq= 5.00kHz
9) VSIM1 at C2212	10) SICIk at I2217	11) SMPSCIk at [2308	12) RFCLK at J2851 & J2852
chl: phph-3.16 V chl: freg Hz	chirds = 1.02 V, ms = 1.37 V physe 2.04 V, Freq= 32.788z	chl:dc = 900eV, me = 1.29 V pipk= 2.21 V, frag= 2.40MHz	chlide = 500mV, ms = 520mV pkpk= 433mV, Excep 38.095z
2 - 4 4 CG 1.00 V- MB10.0w db1+	3	3	
13) RFBusClk at J2833	14) RFBusDa at J2834	15) RFBusEn1X at J2835	16) RX I/Q at J2828-2831
chlido = 930mW, rms = 1.32 V pkpk= 2.41 V, freq= 9.5309m	chlido = 932nV, mm = 1.30 V pkpk= 2.05 V, freq= 4.798Hz	chl:dc = 444mV, ms = 927mV pkpk= 2.06 V, freq= 291kHz	chlido - 45%W, ms - 514aV piple 755W, frage 526 Hz
- m m m m			
17) Camera(LK at 13302	18) CameraSDA at I2803	19) CameraSCL at I2804	20) SDRAMCIk at 13001
chlido = 9236V, ms = 1.30 V pkpk= 2.10 V, free= 9.5549z	ch1:do = 304eV, ma = 722.eV	chlide - 913eV, ma - 1.20 V nimie 1.97 V, frage 98, 101	chlido - 61.6mV, mms - 799mV
the start of parent strategies		• • • • • • • • • • • • • • • • • • •	DEDEM 2.27 V. ECOOM 113002
1 - A. Un (n		M M PA PA M M PA PA PA PA PA	Cic 5006* 1235.004 cht+
21) FlashClk at J3004	22) RFCLKEXT at L7561	m m	24) TXC GSM900 PL5 at L7011
1 0	CE 10044 HEEDO.005 cht 4	M M	Dear 1x V, 1x00 12000 A A A A A A A A A A A A A A A A A A A
1 1	CII. 100% PEDIO.000 ch14 201 100% PEDIO.000 ch14 201 100% PEDIO.000 ch14 201 100% PEDIO.000 ch14	M M	24) TXC GSM900 PL5 at L7011 CSL 25065 M35. Come chit 24) TXC GSM900 PL5 at L7011 CSL 25065 M35. Come chit 28) RX GSM1800 at L7501
21) FlashClk at J3004 District + 0500, ros = 1,57 y at the second seco	CIL 10044 PEDIO (See of 14	M M	240 TAX 4 V. 100 14000 00 5000 10 10 10 10 10 10 10 10 10 10 10 10
21) FlashClk at J3004 at	CIL 1004- 1000 at L7501	M M	24) TXC GSM900 PL5 at L7011 CG 5000* K95.00# abit 24) TXC GSM900 PL5 at L7011 CG 5000* K95.00# abit 24) TXC GSM900 PL5 at L7011 CG 5000* K95.00# abit 28) RX GSM1800 at L7501 CS 8000* K95.00# abit 28) RX GSM1800 at L7501 CS 8000* K95.00# abit 2000* K95.00#





Component finder

B (2272 L5 (3300 P6 D3300 07 J2310 J3 J7500 T8 R2035 D5	R6100 G7			4	5	6	7 8			9	8	7	6	5	4
B2100 B6 (2273 K4 (3302 K4 E2001 D4 J2311 K3 L2000 A5 R2036 D5 B2101 T6 (2273 K4 (3302 K4 E2001 D4 J2312 K3 L2000 A5 R2044 H5 R2046 H5 R2046 L5 R20	R6102 H7														
C C2200 M3 C2203 M4 C3303 O8 E2002 A0 J2313 K3 L2030 C5 R2444 E3 C C2281 L2 C304 O8 E2002 A0 J2314 K3 L2030 C4 R2049 D4 C C2281 L2 C304 O8 E2003 D4 J2314 K3 L2031 C4 R2049 D4 C C2300 L4 C3040 O2000 D4 J2314 K3 L2031 C4 R2049 D4 Dagonal L4 C3040 C2040 D4 J2314 K3 L2031 C4 R2049 D4	R6104 G7				E7001	C [2103] [2	2106		\cup	(0)			\bigcirc	S2403	Z2401
C2000 AA C2300 JA C3305 06 E2010 A7 J2315 J3 E2032 D5 R2050 C4 C2001 A3 C2301 J4 C3306 08 E2070 P3 J2316 K2 L2033 D5 R2051 C5	R7001 T8	E5003C	x1001					DE7501		E2405					
C2002 AS C2302 KS C3307 08 E2071 P3 J2401 C2 L2034 D5 R2052 C4 C2008 C2 C2303 I3 G3308 N5 E2075 P4 J2402 C8 L2035 C5 R2070 E2	R7002 18 R7501 R4	EEGO1C BEA	2414 2413 - K 2414 2418 - K 2416 - K	22405 202022419	BP101			DE7502	T						
C2030 E5 C2304 K4 C3309 N5 E2101 Q6 J2403 D2 L2102 Q7 R2071 N2 C2031 E5 C2305 I2 C3310 P6 E2102 Q9 J2404 D2 L2103 Q8 R2072 E4	R7502 S5 R7503 Q5	S2402		° [7554	E750] [750] [7504]		27520 27523 S		C						
C2032 D5 C2306 I4 C3313 O8 E2103 U6 J2405 C8 L2104 A7 R2074 E5 C2033 E4 C2307 I4 C3314 P8 E2104 T6 I2406 C8 L2105 O2 R2100 H5	R7505 R4		3 (20)73	67500		2750 2 1750 1750			5						
C2034 E4 C2309 I5 C6020 T2 E2105 U7 J2407 D8 L2106 02 R2101 H5 C2035 C5 C3312 I3 C6031 P1 E2106 T6 I2408 P8 L2202 M2 P2102 T5	R7507 S5	22402		2501 C7611 B	N7505	LING C	N75	20	R						
C2055 C5 C2512 IS C0052 R1 C2100 T0 J2400 D0 C2C202 H2 R2102 F5 C2040 H5 C2313 I3 C0052 P2 E2401 C9 J2409 C2 L2207 N4 R2103 T5 C2040 H5 C2313 I3 C0052 P2 E2401 C9 J2409 C2 L2207 N4 R2103 T5	R7509 Q4	15001 E 25030		27560,750 27503,750 27501,751 27501,751	20 20 20 20 20 20 20 20 20 20 20 20 20 2	\$756£7563									
C2041 C3 C2314 J2 C6033 P2 E2402 C1 J2410 D2 L2208 N4 R2104 A8 C2042 D4 C2315 K2 G6034 P2 E2402 N1 J2411 D8 L2209 M5 R2105 A8	R7510 Q8 R7522 Q8			3 3 C750		7561	752475237523	7503775107525	Q						
C2043 C4 C2317 J2 C6035 P1 E2405 T9 J2412 C2 L2210 M5 R2106 N5 C2044 C4 C2403 N2 C6036 P2 E2407 N9 J2418 I5 L2211 M4 R2107 N5	R7523 S8 R7560 Q6	8 NSC30	230763 + 230763 + 230763 + 230763	12305 S		E2101C	15105 + + [151	20153 [00							
C2045 D5 C2404 T2 C6037 P2 E2506 T1 J2419 H5 L2212 M4 R2200 M2 C2046 C4 C2405 T4 C6038 01 E6001 T1 I2421 N2 L2270 L4 R2201 N2	S S2401 01 □				¥2200	C3300	0	13303	P						
C2047 C4 C2413 12 C6039 Q2 E6003 T1 J2428 J1 L2271 L4 R2202 M5 C2048 C3 C2414 T2 C6040 P2 E7000 U8 12429 N1 L2272 K4 R2203 M5	52402 S1	210 210 2		1 .2075			03300								
C2049 H5 C2415 T4 C6040 Q2 E7001 U5 J2429 H3 E2273 K4 R2205 H5 C2049 H5 C2415 T4 C6040 Q2 E7001 U5 J2430 L1 L2273 K4 R2204 M5		Sept 20	x2070		4			3306 3394	0						
C2050 D5 C2410 15 C0052 Q2 E7301 19 J2431 N9 L2301 14 R2203 H5 C2051 H5 C2417 T3 C6055 Q2 E7301 79 J2600 F5 L2302 J4 R2212 L4	T6001 R1	243 2403 BS	RECOG	2011 2011 2001 2001 2001	200 200 200 200 200 200 200 200 200 200			201	NI	E2407					
C2052 C5 C2418 T3 C6100 G7 E7503 U8 J2803 M6 L2304 J2 R2213 N3 C2071 Q3 C2700 H2 C6101 H6 F J2804 M6 L2305 I3 R2216 N3	T6002 P1 \			ब ब	4			2007							
C2073 S2 C2701 H2 C6102 G7 F2000 A5 J2828 N7 L2306 I3 R2250 N2 C2074 L2 C2800 L8 C6103 G7 G J2829 N7 L2402 T3 R2251 N2	T6004 Q1 T6005 Q2	E2205: 52079				- 15801 - 15801		2814 2803 2803	M						
C2076 04 C2801 N8 C6104 H6 G2200 C2 J2830 N7 L2403 J2 R2303 H3 C2077 M2 C2802 M8 C6105 G6 G7500 S4 I2831 N7 L2404 T3 R2400 G4	T7501 R3		C2201	26 00 20 20 20 20 20 20 20 20 20 20 20 20	12202	029	00	2003							
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RM-217; RM-222 Schematics



Nokia Customer Care

Glossary



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A/D-converter	Analog-to-digital converter
ACI	Accessory Control Interface
ADC	Analog-to-digital converter
ADSP	Application DPS (expected to run high level tasks)
AGC	Automatic gain control (maintains volume)
ALS	Ambient light sensor
AMSL	After Market Service Leader
ARM	Advanced RISC Machines
ARPU	Average revenue per user (per month or per year)
ASIC	Application Specific Integrated Circuit
ASIP	Application Specific Interface Protector
B2B	Board to board, connector between PWB and UI board
BB	Baseband
BC02	Bluetooth module made by CSR
BIQUAD	Bi-quadratic ,type of filter function)
BSI	Battery Size Indicator
BT	Bluetooth
CBus	MCU controlled serial bus connected to UPP_WD2,UEME and Zocus
ССР	Compact Camera Port
CDSP	Cellular DSP (expected to run at low levels)
CLDC	Connected limited device configuration
CMOS	Complimentary metal-oxide semiconductor circuit (low power consumption)
COF	Chip on Foil
COG	Chip on Glass
CPU	Central Processing Unit
CSR	cambridge silicon radio
CSTN	Color Super Twisted Nematic
CTSI	Clock Timing Sleep and interrupt block of Tiku
CW	Continuous wave
D/A-converter	Digital-to-analouge converter
DAC	Digital-to-analouge converter
DBI	Digital Battery Interface
DBus	DSP controlled serial bus connected between UPP_WD2 and Helgo
DCT-4	Digital Core Technology
DMA	Direct memory access
DP	Data Package

DPLL	Digital Phase Locked Loop
DSP	Digital Signal Processor
DtoS	Differential to Single ended
EDGE	Enhanced data rates for global/GSM evaluation
EGSM	Extended GSM
EM	Energy management
EMC	Electromagnetic compability
EMI	Electromagnetic interference
ESD	Electrostatic discharge
FCI	Functional cover interface
FPS	Flash Programming Tool
FR	Full rate
FSTN	Film compensated super twisted nematic
GND	Ground, conductive mass
GPIB	General-purpose interface bus
GPRS	General Packet Radio Service
GSM	Group Special Mobile/Global System for Mobile communication
HF	Hands free
HFCM	Handsfree Common
HS	Handset
HSCSD	High speed circuit switched data (data transmission connection faster than GSM)
HW	Hardware
I/0	Input/Output
IBAT	Battery current
IC	Integrated circuit
ICHAR	Charger current
IF	Interface
IHF	Integrated hands free
IMEI	International Mobile Equipment Identity
IR	Infrared
IrDA	Infrared Data Associasion
ISA	Intelligent software architecture
JPEG/JPG	Joint Photographic Experts Group
LCD	Liquid Crystal Display
LDO	Low Drop Out
LED	Light-emitting diode

LPRF	Low Power Radio Frequency
МСИ	Micro Controller Unit (microprocessor)
МСИ	Multiport control unit
MIC, mic	Microphone
MIDP	Mobile Information Device Profile
MIN	Mobile identification number
MIPS	Million instructions per second
ММС	Multimedia card
MMS	Multimedia messaging service
NTC	Negative temperature coefficient, temperature sensitive resistor used as a temperature sensor
ОМА	Object management architechture
ОМАР	Operations, maintenance, and administartion part
Opamp	Operational Amplifier
РА	Power amplifier
PDA	Pocket Data Application
PDA	Personal digital assistant
PDRAM	Program/Data RAM (on chip in Tiku)
Phoenix	Software tool of DCT4.x
PIM	Personal Information Management
PLL	Phase locked loop
РМ	(Phone) Permanent memory
PUP	General Purpose IO (PIO), USARTS and Pulse Width Modulators
PURX	Power-up reset
PWB	Printed Wiring Board
PWM	Pulse width modulation
RC-filter	Resistance-Capacitance filter
RF	Radio Frequency
RF PopPort TM	Reduced function PopPortTM interface
RFBUS	Serial control Bus For RF
RSK	Right Soft Key
RS-MMC	Reduced size Multi Media Card
RSSI	Receiving signal strength indicator
RST	Reset Switch
RTC	Real Time Clock (provides date and time)
RX	Radio Receiver

SARAM	Single Access RAM
SAW filter	Surface Acoustic Wave filter
SDRAM	Synchronous Dynamic Random Access Memory
SID	Security ID
SIM	Subscriber Identity Module
SMPS	Switched Mode Power Supply
SNR	Signal-to-noice ratio
SPR	Standard Product requirements
SRAM	Static random access memory
STI	Serial Trace Interface
SW	Software
SWIM	Subscriber/Wallet Identification Module
ТСХО	Temperature controlled Oscillator
Tiku	Finnish for Chip, Successor of the UPP, Official Tiku3G
ТХ	Radio Transmitter
UART	Universal asynchronous receiver/transmitter
UEME	Universal Energy Management chip (Enhanced version)
UEMEK	See UEME
UI	User Interface
UPP	Universal Phone Processor
UPP_WD2	Communicator version of DCT4 system ASIC
USB	Universal Serial Bus
VBAT	Battery voltage
VCHAR	Charger voltage
VCO	Voltage controlled oscillator
VCTCXO	Voltage Controlled Temperature Compensated Crystal Oscillator
VCXO	Voltage Controlled Crystal Oscillator
Vр-р	Peak-to-peak voltage
VSIM	SIM voltage
WAP	Wireless application protocol
WD	Watchdog
XHTML	Extensible hypertext markup language
Zocus	Current sensor, (used to monitor the current flow to and from the battery)

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